

# Parallel NOR Flash Automotive Memory

**MT28FW01GABA1xPC-0AAT, MT28FW01GABA1xJS-0AAT**

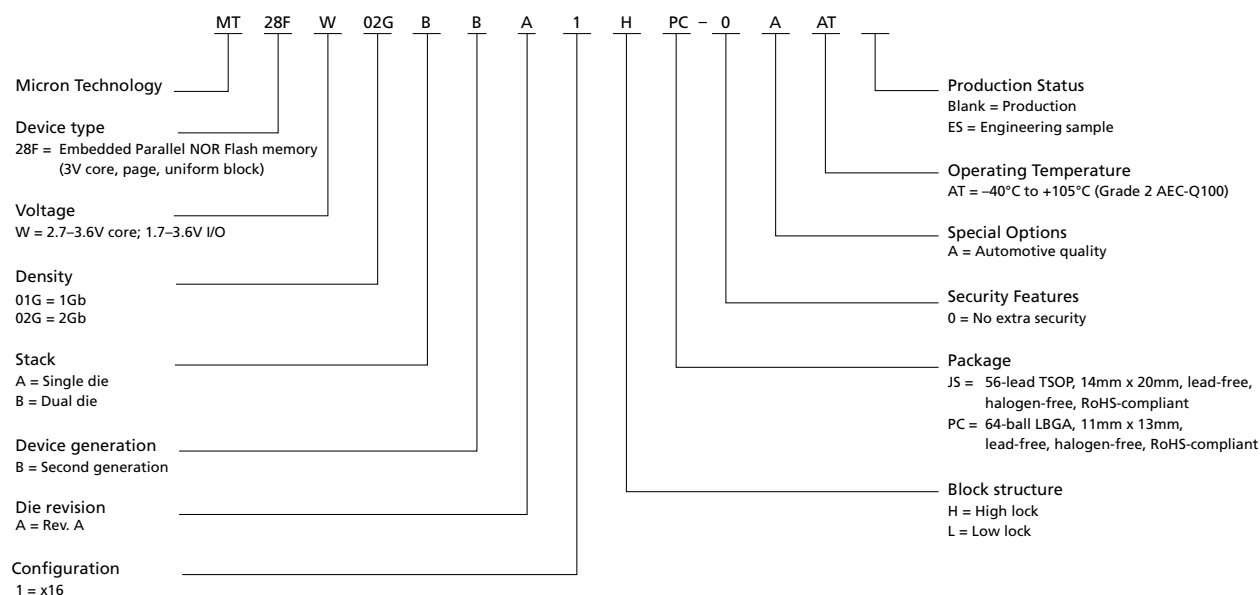
## Features

- Single-level cell (SLC) process technology
- Supply voltage
  - $V_{CC} = 2.7\text{--}3.6\text{V}$  (program, erase, read)
  - $V_{CCQ} = 1.65 - V_{CC}$  (I/O buffers)
- Asynchronous random/page read
  - Page size: 16 words
  - Page access: 20ns ( $V_{CC} = V_{CCQ} = 2.7\text{--}3.6\text{V}$ )
  - Random access: 105ns ( $V_{CC} = V_{CCQ} = 2.7\text{--}3.6\text{V}$ )
  - Random access: 110ns ( $V_{CCQ} = 1.65\text{--}V_{CC}$ )
- Buffer program (512-word program buffer)
  - 2.0 MB/s (TYP) when using full buffer program
  - 2.5 MB/s (TYP) when using accelerated buffer program ( $V_{HH}$ )
- Word program: 25us per word (TYP)
- Block erase (128KB): 0.2s (TYP)
- Memory organization
  - Uniform blocks: 128KB or 64KW each
  - x16 data bus
- Program/erase suspend and resume capability
  - Read from another block during a PROGRAM SUSPEND operation
  - Read or program another block during an ERASE SUSPEND operation
- Unlock bypass, block erase, chip erase, and write to buffer capability
- BLANK CHECK operation to verify an erased block
- CYCLIC REDUNDANCY CHECK (CRC) operation to verify a program pattern
- $V_{PP}/WP\#$  protection
  - Protects first or last block regardless of block protection settings
- Software protection
  - Volatile protection
  - Nonvolatile protection
  - Password protection
- Extended memory block
  - 512-word block for permanent, secure identification
  - Programmed or locked at the factory or by the customer
- JESD47-compliant
  - 100,000 (minimum) ERASE cycles per block
  - Data retention: 20 years (TYP)
- Package
  - 56-pin TSOP, 14mm x 20mm (JS)
  - 64-ball LBGA, 13mm x 11mm (PC)
- RoHS-compliant, halogen-free packaging
- Automotive operating temperature
  - Ambient:  $-40^{\circ}\text{C}$  to  $105^{\circ}\text{C}$

## Part Numbering Information

For available options, such as packages or high/low protection, or for further information, contact your Micron sales representative. Part numbers can be verified at [www.micron.com](http://www.micron.com). Feature and specification comparison by device type is available at [www.micron.com/products](http://www.micron.com/products). Contact the factory for devices not found.

**Figure 1: Part Number Chart**



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## Important Notes and Warnings

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## General Description

The device is an asynchronous, uniform block, parallel NOR Flash memory device. READ, ERASE, and PROGRAM operations are performed using a single low-voltage supply. Upon power-up, the device defaults to read array mode.

The main memory array is divided into uniform blocks that can be erased independently so that valid data can be preserved while old data is purged. PROGRAM and ERASE commands are written to the command interface of the memory. An on-chip program/erase controller simplifies the process of programming or erasing the memory by taking care of all special operations required to update the memory contents. The end of a PROGRAM or ERASE operation can be detected and any error condition can be identified. The command set required to control the device is consistent with JEDEC standards.

CE#, OE#, and WE# control the bus operation of the device and enable a simple connection to most microprocessors, often without additional logic.

The device supports asynchronous random read and page read from all blocks of the array. It also features an internal program buffer that improves throughput by programming 512 words via one command sequence. A 512-word extended memory block overlaps addresses with array block 0. Users can program this additional space and then protect it to permanently secure the contents. The device also features different levels of hardware and software protection to secure blocks from unwanted modification.

## Automatic Power Savings Feature

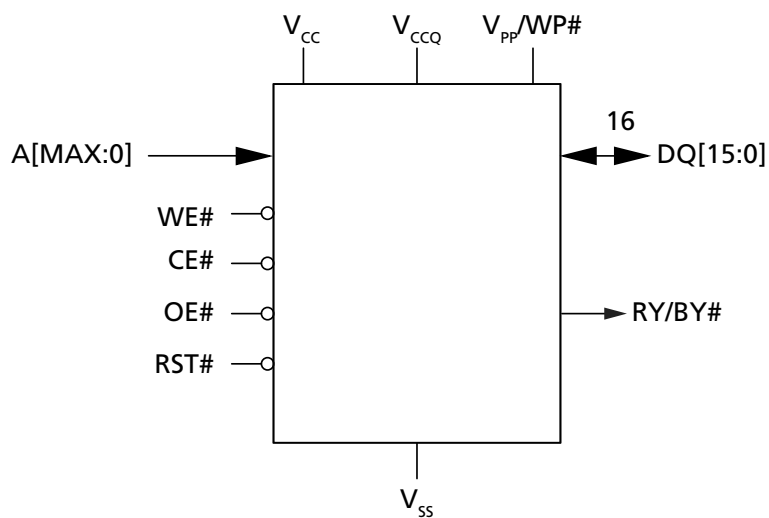
The automatic power savings feature provides low power operation during reads.

After data is read from the memory array and the address lines are quiescent, the automatic power savings feature reduces device current to a low value of  $I_{CCAPS}$ .

During automatic power savings mode, average current is measured over 5ms time interval 5 $\mu$ s after the following events happen:

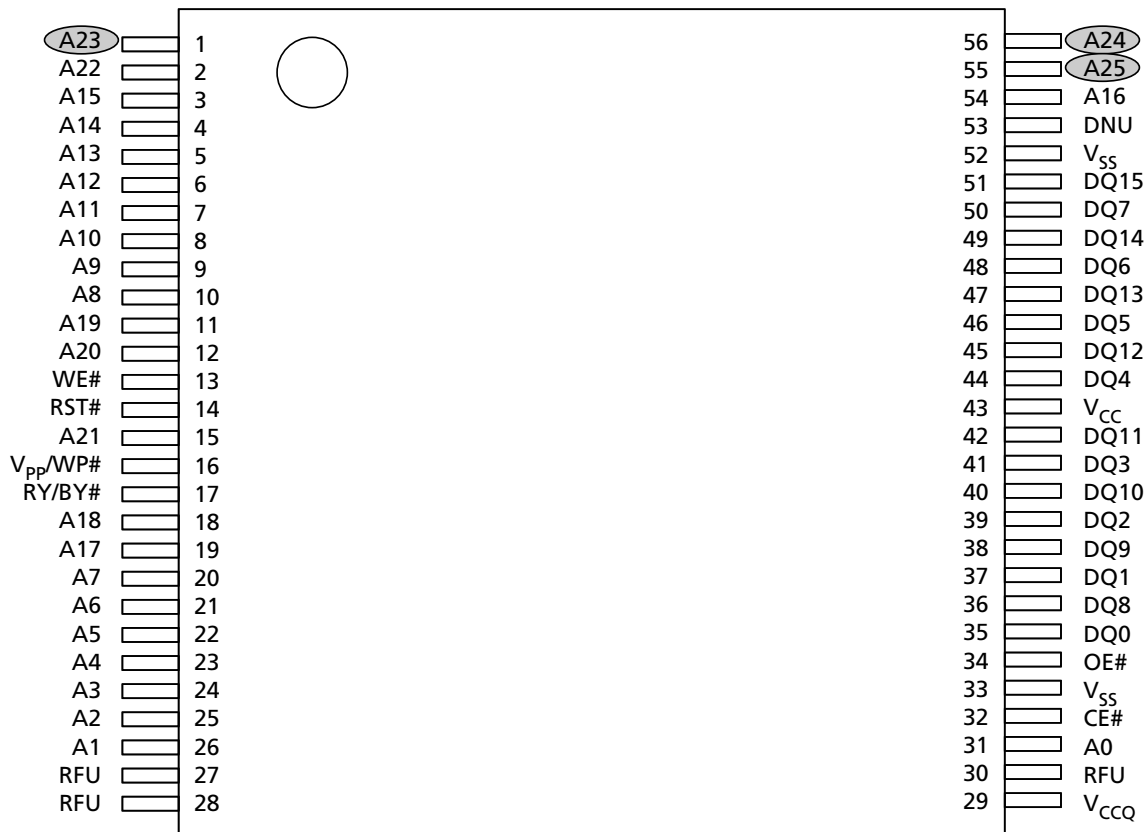
- No internal read, program or erase activity occurring
- RST# is deasserted and CE# is asserted
- All other signals are quiescent and at  $V_{SS}$  or  $V_{CCQ}$

**Figure 2: Logic Diagram**



## Signal Assignments

Figure 3: 56-Pin TSOP (Top View)



- Notes:
1. A23 is valid for 256Mb and above; otherwise, it is RFU.
  2. A24 is valid for 512Mb and above; otherwise, it is RFU.
  3. A25 is valid for 1Gb and above; otherwise, it is RFU.

**Figure 4: 64-Ball LBGGA (Top View – Balls Down)**

|   | 1                | 2               | 3   | 4                    | 5               | 6    | 7               | 8                |
|---|------------------|-----------------|-----|----------------------|-----------------|------|-----------------|------------------|
| A | NC               | A3              | A7  | RY/BY#               | WE#             | A9   | A13             | NC               |
| B | NC               | A4              | A17 | V <sub>PP</sub> /WP# | RST#            | A8   | A12             | A22              |
| C | NC               | A2              | A6  | A18                  | A21             | A10  | A14             | A23              |
| D | NC               | A1              | A5  | A20                  | A19             | A11  | A15             | V <sub>CCQ</sub> |
| E | NC               | A0              | DQ0 | DQ2                  | DQ5             | DQ7  | A16             | V <sub>SS</sub>  |
| F | V <sub>CCQ</sub> | CE#             | DQ8 | DQ10                 | DQ12            | DQ14 | RFU             | A24              |
| G | NC               | OE#             | DQ9 | DQ11                 | V <sub>CC</sub> | DQ13 | DQ15            | A25              |
| H | NC               | V <sub>SS</sub> | DQ1 | DQ3                  | DQ4             | DQ6  | V <sub>SS</sub> | NC               |

- Notes:
1. A23 is valid for 256Mb and above; otherwise, it is RFU.
  2. A24 is valid for 512Mb and above; otherwise, it is RFU.
  3. A25 is valid for 1Gb and above; otherwise, it is RFU.

## Signal Descriptions

The signal description table below is a comprehensive list of signals for this device family. All signals listed may not be supported on this device. See Signal Assignments for information specific to this device.

**Table 1: Signal Descriptions**

| Name                 | Type   | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|----------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A[MAX:0]             | Input  | <b>Address:</b> Selects the cells in the array to access during READ operations. During WRITE operations, they control the commands sent to the command interface of the program/erase controller.                                                                                                                                                                                                                                                                                                                                                                                                          |
| CE#                  | Input  | <b>Chip enable:</b> Activates the device, enabling READ and WRITE operations to be performed. When CE# is HIGH, the device goes to standby and data outputs are High-Z.                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| OE#                  | Input  | <b>Output enable:</b> Active LOW input. OE# LOW enables the data output buffers during READ cycles. When OE# is HIGH, data outputs are High-Z.                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| WE#                  | Input  | <b>Write enable:</b> Controls WRITE operations to the device. Address is latched on the falling edge of WE# and data is latched on the rising edge.                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| V <sub>pp</sub> /WP# | Input  | <b>V<sub>pp</sub>/Write Protect:</b> Provides WRITE PROTECT function and V <sub>HH</sub> function. These functions protect the lowest or highest block and enable the device to enter unlock bypass mode, respectively. (Refer to Hardware Protection and Bypass Operations for details.)                                                                                                                                                                                                                                                                                                                   |
| RST#                 | Input  | <b>Reset:</b> Applies a hardware reset to the device control logic and places it in standby, which is achieved by holding RST# LOW for at least <sup>t</sup> PLPH. After RST# goes HIGH, the device is ready for READ and WRITE operations (after <sup>t</sup> PHL or <sup>t</sup> PHWL, whichever occurs last).                                                                                                                                                                                                                                                                                            |
| DQ[15:0]             | I/O    | <b>Data I/O:</b> Outputs the data stored at the selected address during a READ operation. During WRITE operations, they represent the commands sent to the command interface of the internal state machine.                                                                                                                                                                                                                                                                                                                                                                                                 |
| RY/BY#               | Output | <b>Ready busy:</b> Open-drain output that can be used to identify when the device is performing a PROGRAM or ERASE operation. During PROGRAM or ERASE operations, RY/BY# is LOW, and is High-Z during read mode, auto select mode, and erase suspend mode. The use of an open-drain output enables the RY/BY# pins from several devices to be connected to a single pull-up resistor to V <sub>CCQ</sub> . A low value will then indicate that one (or more) of the devices is (are) busy. A 10K Ohm or bigger resistor is recommended as pull-up resistor to achieve 0.1V V <sub>OL</sub> .                |
| V <sub>CC</sub>      | Supply | <b>Supply voltage:</b> Provides the power supply for READ, PROGRAM, and ERASE operations. The device is disabled when V <sub>CC</sub> ≤ V <sub>LKO</sub> . If the program/erase controller is programming or erasing during this time, then the operation aborts and the contents being altered will be invalid.<br>A 0.1μF and 0.01μF capacitor should be connected between V <sub>CC</sub> and V <sub>SS</sub> to decouple the current surges from the power supply. The PCB track widths must be sufficient to carry the currents required during PROGRAM and ERASE operations (see DC Characteristics). |
| V <sub>CCQ</sub>     | Supply | <b>I/O supply voltage:</b> Provides the power supply to the I/O pins and enables all outputs to be powered independently from V <sub>CC</sub> .<br>A 0.1μF and 0.01μF capacitor should be connected between V <sub>CCQ</sub> and V <sub>SS</sub> to decouple the current surges from the power supply.                                                                                                                                                                                                                                                                                                      |
| V <sub>SS</sub>      | Supply | <b>Ground:</b> All V <sub>SS</sub> pins must be connected to the system ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |

**Table 1: Signal Descriptions (Continued)**

| Name | Type | Description                                                                                                                                                                                                                 |
|------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RFU  | —    | <b>Reserved for future use:</b> Reserved by Micron for future device functionality and enhancement. Recommend that these be left floating. May be connected internally, but external connections will not affect operation. |
| DNU  | —    | <b>Do not use:</b> Do not connect to any other signal, or power supply; must be left floating.                                                                                                                              |
| NC   | —    | <b>No connect:</b> No internal connection; can be driven or floated.                                                                                                                                                        |



## Memory Organization

### Memory Configuration

The main memory array is divided into 128KB or 64KW uniform blocks.

### Memory Map

**Table 2: Blocks[1023:0]**

| Block | Address Range |           |
|-------|---------------|-----------|
|       | Start         | End       |
| 1023  | 3FF 0000h     | 3FF FFFFh |
| ⋮     | ⋮             | ⋮         |
| 511   | 1FF 0000h     | 1FF FFFFh |
| ⋮     | ⋮             | ⋮         |
| 255   | 0FF 0000h     | 0FF FFFFh |
| ⋮     | ⋮             | ⋮         |
| 127   | 07F 0000h     | 07F FFFFh |
| ⋮     | ⋮             | ⋮         |
| 63    | 03F 0000h     | 03F FFFFh |
| ⋮     | ⋮             | ⋮         |
| 0     | 000 0000h     | 000 FFFFh |

Note: 1. 1Gb device = Blocks 0–1023.

## Bus Operations

**Table 3: Bus Operations**

Notes 1 and 2 apply to entire table

| Operation         | CE# | OE# | WE# | RST# | V <sub>pp</sub> /WP# | A[ <b>MAX:0</b> ] | DQ[ <b>15:0</b> ]       |
|-------------------|-----|-----|-----|------|----------------------|-------------------|-------------------------|
| READ              | L   | L   | H   | H    | X                    | Address           | Data output             |
| WRITE             | L   | H   | L   | H    | H <sup>3</sup>       | Command address   | Data input <sup>4</sup> |
| STANDBY           | H   | X   | X   | H    | X                    | X                 | High-Z                  |
| OUTPUT<br>DISABLE | L   | H   | H   | H    | X                    | X                 | High-Z                  |
| RESET             | X   | X   | X   | L    | X                    | X                 | High-Z                  |

- Notes:
1. Typical glitches of less than 3ns on CE#, OE#, and WE# are ignored by the device and do not affect bus operations.
  2. H = Logic level HIGH (V<sub>IH</sub>); L = Logic level LOW (V<sub>IL</sub>); X = HIGH or LOW.
  3. If WP# is LOW, then the highest or the lowest block remains protected, depending on line item.
  4. Data input is required when issuing a command sequence or when performing data polling or block protection.

### Read

Bus READ operations read from the memory cells, registers, extended memory block, or CFI space. To accelerate the READ operation, the memory array can be read in page mode where data is internally read and stored in a page buffer.

Page size is 16 words and is addressed by address inputs A[3:0]. The extended memory blocks and CFI area support page read mode.

A valid bus READ operation involves setting the desired address on the address inputs, taking CE# and OE# LOW, and holding WE# HIGH. The data I/Os will output the value. If CE# goes HIGH and returns LOW for a subsequent access, a random read access is performed and t<sub>ACC</sub> or t<sub>CE</sub> is required. (See AC Characteristics for details about when the output becomes valid.)

### Write

Bus WRITE operations write to the command interface. A valid bus WRITE operation begins by setting the desired address on the address inputs. The address inputs are latched by the command interface on the falling edge of CE# or WE#, whichever occurs last. The data I/Os are latched by the command interface on the rising edge of CE# or WE#, whichever occurs first. OE# must remain HIGH during the entire bus WRITE operation (See AC Characteristics for timing requirement details).

### Standby

Driving CE# HIGH in read mode causes the device to enter standby and data I/Os to be High-Z (See DC Characteristics).

During PROGRAM or ERASE operations, the device will continue to use the program/erase supply current ( $I_{CC3}$ ) until the operation completes. The device cannot be placed into standby mode during a PROGRAM/ERASE operation.

## Output Disable

Data I/Os are High-Z when OE# is HIGH.

## Reset

During reset mode the device is deselected and the outputs are High-Z. The device is in reset mode when RST# is LOW. The power consumption is reduced to the standby level, independently from CE#, OE#, or WE# inputs.

When RST# is HIGH, a time of  $t_{PHEL}$  is required before a READ operation can access the device, and a delay of  $t_{PHWL}$  is required before a write sequence can be initiated. After this wake-up interval, normal operation is restored, the device defaults to read array mode, and the data polling register is reset.

If RST# is driven LOW during a PROGRAM/ERASE operation or any other operation that requires writing to the device, the operation will abort within  $t_{PLRH}$ , and memory contents at the aborted block or address are no longer valid.

## Registers

The device features two methods for monitoring internal status during modify operations: data polling status and read status register. Users must not mix the two methods. Only one method at a time must be used to monitor internal operations.

### Data Polling Register

The device automatically enters data polling status mode upon command issuance. The data polling status information uses the following to indicate information: DQ1, DQ2, DQ3, DQ5, DQ6, and DQ7; DQ[15:8] are reserved and will output 00h.

**Table 4: Data Polling Register Bit Definitions**

Note 1 applies to entire table

| Bit | Name                       | Settings                                           | Description                                                                                                                                                                                                                                                                                               | Notes   |
|-----|----------------------------|----------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| DQ7 | Data polling bit           | 0 or 1, depending on operations                    | Monitors whether the program/erase controller has successfully completed its operation, or has responded to an ERASE SUSPEND operation.                                                                                                                                                                   | 2, 4    |
| DQ6 | Toggle bit                 | Toggles: 0 to 1; 1 to 0; and so on                 | Monitors whether the program, erase, or blank check controller has successfully completed its operations, or has responded to an ERASE SUSPEND operation. During a PROGRAM/ERASE/BLANK CHECK operation, DQ6 toggles from 0 to 1, 1 to 0, and so on, with each successive READ operation from any address. | 3, 4, 5 |
| DQ5 | Error bit                  | 0 = Success<br>1 = Failure                         | Identifies errors detected by the program/erase controller. DQ5 is set to 1 when a PROGRAM, BLOCK ERASE, or CHIP ERASE operation fails to write the correct data to the memory, or when a BLANK CHECK or CRC operation fails.                                                                             | 4, 6    |
| DQ3 | Erase timer bit            | 0 = Erase not in progress<br>1 = Erase in progress | Identifies the start of program/erase controller operation during a BLOCK ERASE command. Before the program/erase controller starts, this bit set to 0.                                                                                                                                                   | 4       |
| DQ2 | Alternative toggle bit     | Toggles: 0 to 1; 1 to 0; and so on                 | During CHIP ERASE, BLOCK ERASE, and ERASE SUSPEND operations, DQ2 toggles from 0 to 1, 1 to 0, and so on, with each successive READ operation from addresses within the blocks being erased.                                                                                                              | 3, 4    |
| DQ1 | Buffered program abort bit | 1 = Abort                                          | Indicates a BUFFER PROGRAM, BLANK CHECK, or CRC operation abort. The BUFFERED PROGRAM ABORT and RESET command must be issued to return the device to read mode (see WRITE TO BUFFER PROGRAM command).                                                                                                     |         |

- Notes:
1. The data polling register can be read during PROGRAM, ERASE, or ERASE SUSPEND operations; the READ operation outputs data on DQ[7:0].
  2. For a PROGRAM operation in progress, DQ7 outputs the complement of the bit being programmed. For a READ operation from the address previously programmed successfully, DQ7 outputs existing DQ7 data. For a READ operation from addresses with blocks to be erased while an ERASE SUSPEND operation is in progress, DQ7 outputs 0; upon successful completion of the ERASE SUSPEND operation, DQ7 outputs 1. For an ERASE operation in progress, DQ7 outputs 0; upon ERASE operation's successful completion, DQ7 outputs 1. During a BUFFER PROGRAM operation, the data polling bit is valid only for the last word being programmed in the write buffer.

3. After successful completion of a PROGRAM, ERASE, or BLANK CHECK operation, the device returns to read mode.
4. During erase suspend mode, READ operations to addresses within blocks not being erased output memory array data as if in read mode. A protected block is treated the same as a block not being erased. See the Toggle Flowchart for more information.
5. During erase suspend mode, DQ6 toggles when addressing a cell within a block being erased. The toggling stops when the program/erase controller has suspended the ERASE operation. See the Toggle Flowchart for more information.
6. When DQ5 is set to 1, a READ/RESET (F0h) command must be issued before any subsequent command.

**Table 5: Operations and Corresponding Bit Settings**

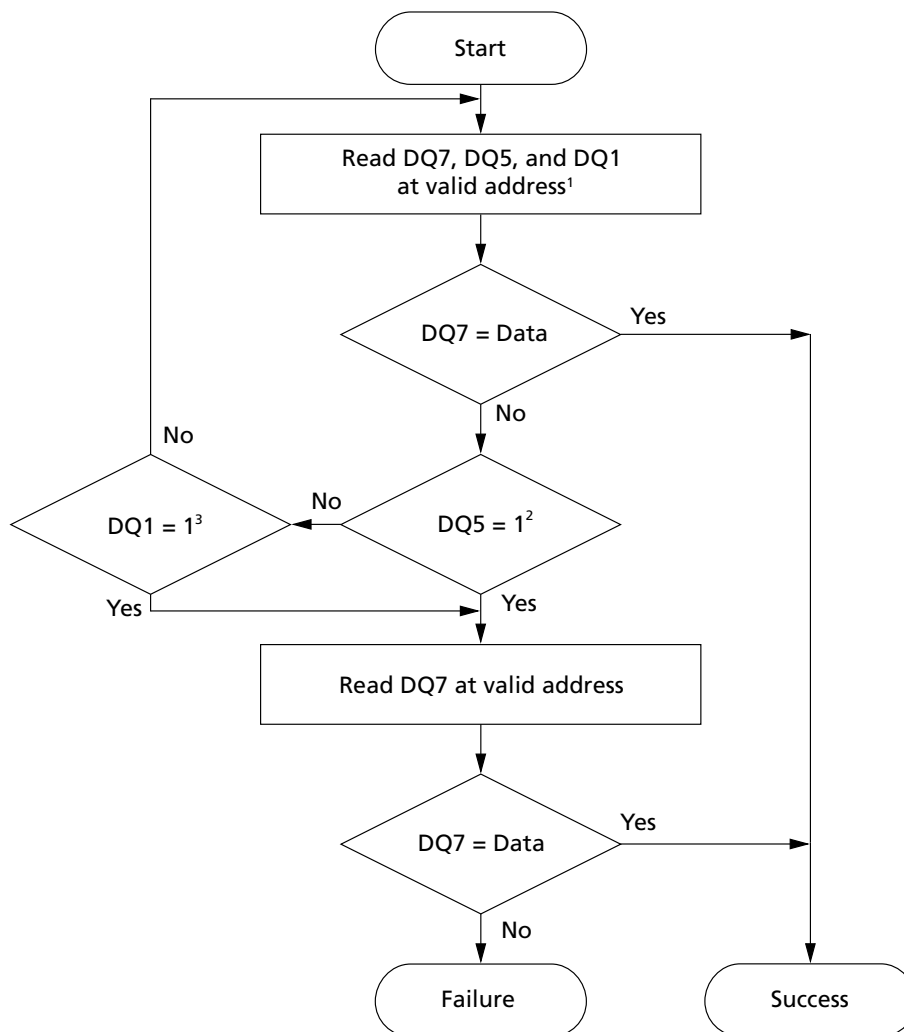
Note 1 applies to entire table

| Operation                    | Address                  | DQ7                                          | DQ6       | DQ5 | DQ3 | DQ2       | DQ1 | RY/BY# | Notes |
|------------------------------|--------------------------|----------------------------------------------|-----------|-----|-----|-----------|-----|--------|-------|
| PROGRAM                      | Any address              | DQ7#                                         | Toggle    | 0   | –   | –         | 0   | 0      | 2     |
| CRC range of blocks          | Any address              | 1                                            | Toggle    | 0   | –   | –         | 0   | 0      |       |
| CRC chip                     | Any address              | DQ7#                                         | Toggle    | 0   | –   | –         | 0   | 0      | 4     |
| CHIP ERASE                   | Any address              | 0                                            | Toggle    | 0   | 1   | Toggle    | –   | 0      |       |
| BLANK CHECK                  | Blank-checking block     | 0                                            | Toggle    | 0   | 1   | Toggle    | –   | 0      |       |
|                              | Non-blank-checking block | 0                                            | Toggle    | 0   | 1   | No toggle | –   | 0      |       |
| BLOCK ERASE                  | Erasing block            | 0                                            | Toggle    | 0   | 1   | Toggle    | –   | 0      |       |
|                              | Non-erasing block        | 0                                            | Toggle    | 0   | 1   | No toggle | –   | 0      |       |
| PROGRAM SUSPEND              | Programming block        | Invalid operation                            |           |     |     |           |     | High-Z |       |
|                              | Nonprogramming block     | Outputs memory array data as if in read mode |           |     |     |           |     | High-Z |       |
| ERASE SUSPEND                | Erasing block            | 1                                            | No Toggle | 0   | –   | Toggle    | –   | High-Z |       |
|                              | Non-erasing block        | Outputs memory array data as if in read mode |           |     |     |           |     | High-Z |       |
| PROGRAM during ERASE SUSPEND | Erasing block            | DQ7#                                         | Toggle    | 0   | –   | Toggle    | –   | 0      | 2     |
|                              | Non-erasing block        | DQ7#                                         | Toggle    | 0   | –   | No Toggle | –   | 0      | 2     |
| BUFFERED PROGRAM ABORT       | Any address              | DQ7#                                         | Toggle    | 0   | –   | –         | 1   | High-Z |       |
| PROGRAM Error                | Any address              | DQ7#                                         | Toggle    | 1   | –   | –         | –   | High-Z | 2     |
| ERASE Error                  | Any address              | 0                                            | Toggle    | 1   | 1   | Toggle    | –   | High-Z |       |
| BLANK CHECK Error            | Any address              | 0                                            | Toggle    | 1   | 1   | Toggle    | –   | High-Z |       |
| CRC range of blocks error    | Any address              | 1                                            | Toggle    | 1   | –   | –         | –   | High-Z |       |
| CRC chip error               | Any address              | DQ7#                                         | Toggle    | 1   | –   | –         | –   | High-Z | 4     |

- Notes:
1. Unspecified data bits should be ignored.
  2. DQ7# for buffer program is related to the last address location loaded.

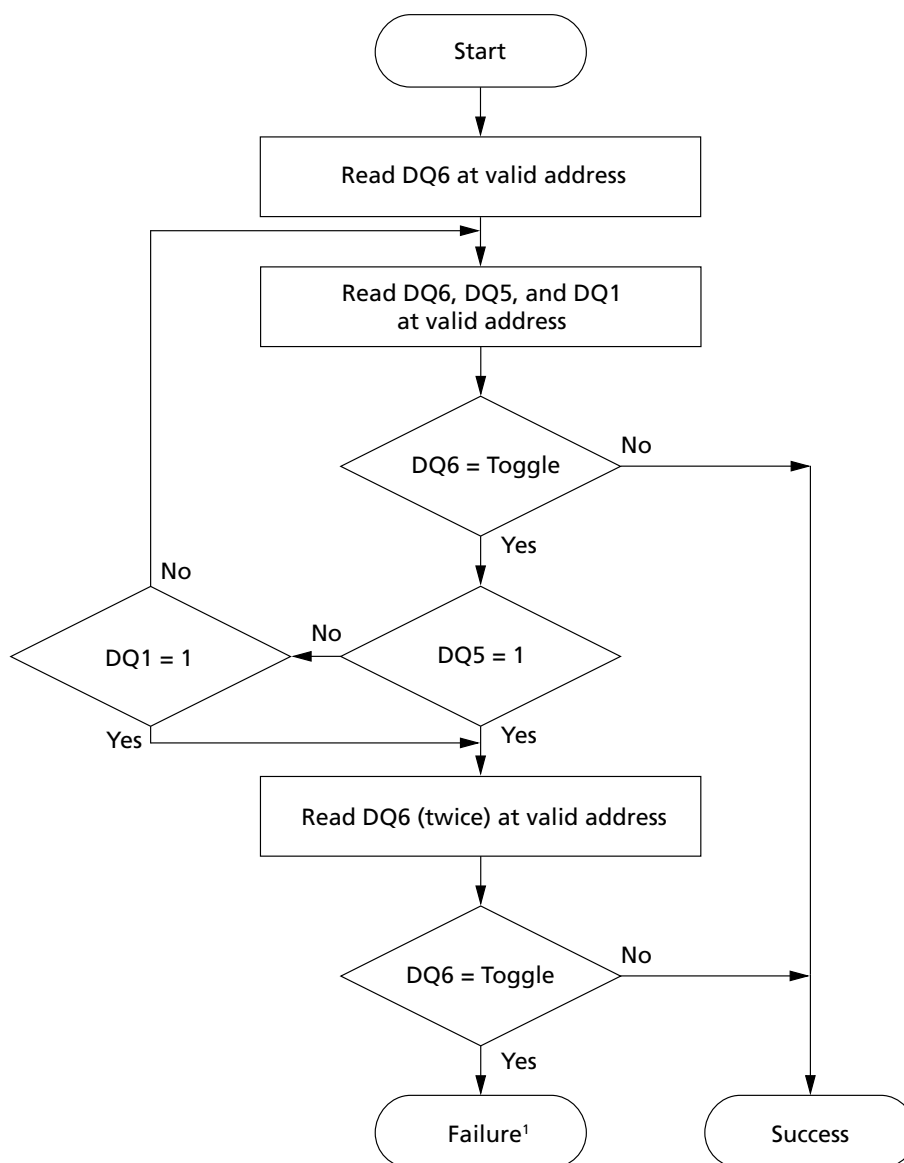
3. DQ7# is the reverse DQ7 of the last word or byte loaded before CRC chip confirm command cycle.

**Figure 5: Data Polling Flowchart**



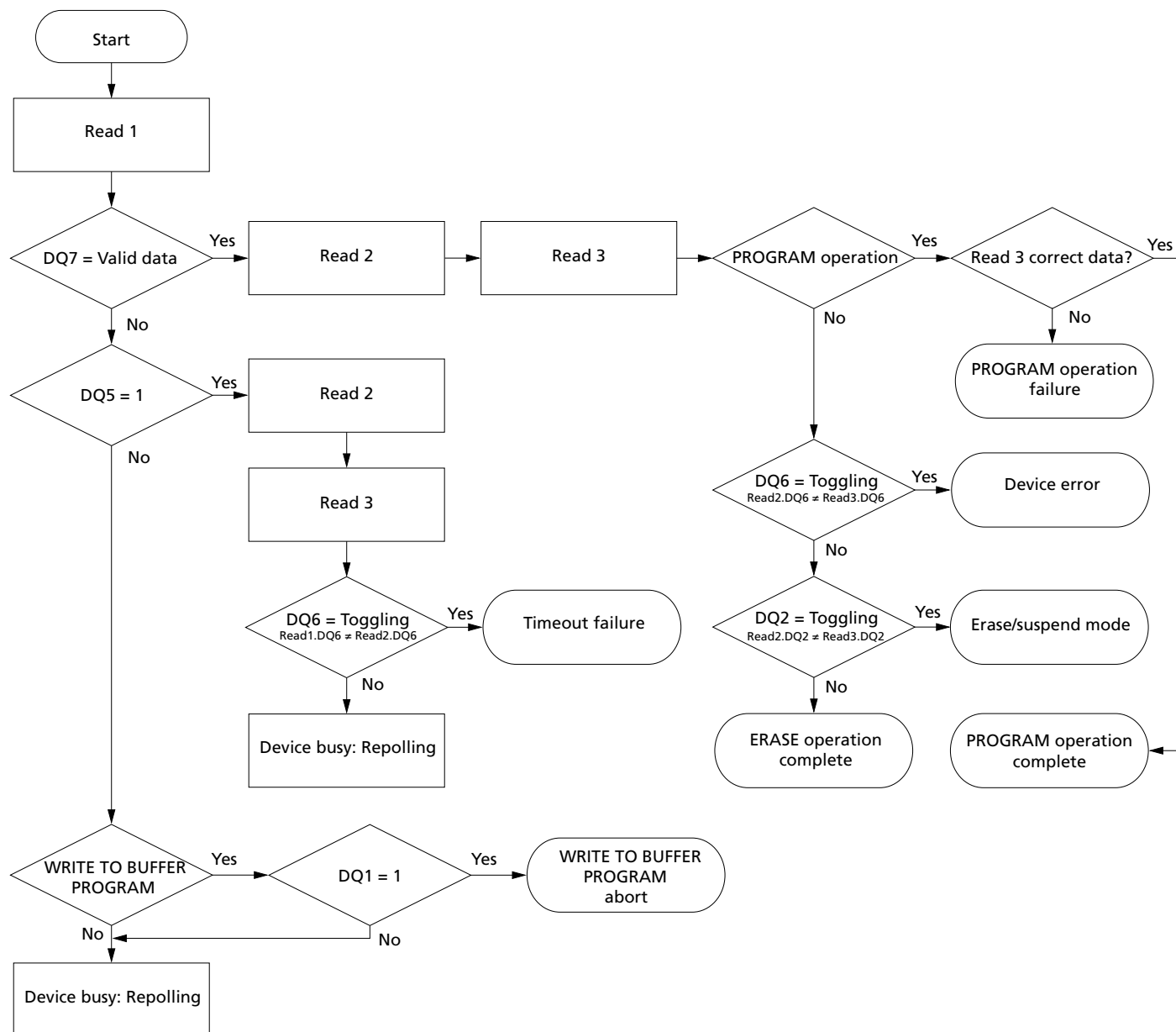
- Notes:
1. Valid address is the last address being programmed or an address within the block being erased.
  2. Failure results: DQ5 = 1 indicates an operation error. A READ/RESET (F0h) command must be issued before any subsequent command.
  3. Failure results: DQ1 = 1 indicates a WRITE TO BUFFER PROGRAM ABORT operation. A full three-cycle RESET (AAh/55h/F0h) command sequence must be used to reset the aborted device.

**Figure 6: Toggle Bit Flowchart**



Note: 1. Failure results: DQ5 = 1 indicates an operation error; DQ1 = 1 indicates a WRITE TO BUFFER PROGRAM ABORT operation.

**Figure 7: Data Polling/Toggle Bit Flowchart**



## Read Status Register

The device's status register displays PROGRAM, ERASE, and BLANK CHECK operations status. A device's status can be read after writing the READ STATUS REGISTER command (70h). When the READ STATUS REGISTER command is issued, the current status is captured by the register and the device is in read status register mode. The first read access in the status register mode exits the mode and returns to the output state when the READ STATUS REGISTER command was issued. No other command should be sent before reading the status register to exit the status register mode.

The status register bits are output on DQ[7:0], while DQ[15:8] outputs are 00h.

**Table 6: Status Register Definitions**

| Bit      | Name                                    | Settings                                                             | Description                                                                                                                                                                           |
|----------|-----------------------------------------|----------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SR[15:8] | –                                       | Reserved                                                             | Reserved for future use. Will always be set to 0.                                                                                                                                     |
| SR7      | Device program/erase/blank check status | 0 = Busy<br>1 = Ready                                                | Indicates erase, program, or blank check completion in the device. SR[6:1] are invalid; SR7 = 0.                                                                                      |
| SR6      | Erase suspend status                    | 0 = Erase in progress/complete<br>1 = Erase suspended                | Indicates whether the device is erase suspended. After issuing an ERASE SUSPEND command, SR7 and SR6 are set to 1. SR6 remains set until the device receives an ERASE RESUME command. |
| SR5      | Erase/blank check status                | 0 = Erase/blank check successful<br>1 = Erase/blank check error      | Set to 1 if an attempted erase or blank check failed.                                                                                                                                 |
| SR4      | Program status                          | 0 = Program success<br>1 = Program error                             | Indicates whether the program failed or the buffer program has aborted.                                                                                                               |
| SR3      | Writer buffer abort status              | 0 = Program not aborted<br>1 = Program aborted during buffer program | Indicates whether the buffer program has aborted.                                                                                                                                     |
| SR2      | Program suspend status                  | 0 = Program in progress/complete<br>1 = Program suspended            | Indicates whether the device is program suspended. After receiving a PROGRAM SUSPEND command, SR7 and SR2 are set to 1, and remain set at 1 until a RESUME command is received.       |
| SR1      | Device protect status                   | 0 = Unlocked<br>1 = Aborted erase/program attempt on a locked block  | Indicates whether program or erase was attempted on a locked block. If an ERASE or PROGRAM operation is attempted on a locked block, SR1 is set to 1 and the operation aborts.        |
| SR0      | –                                       | Reserved                                                             | Reserved for future use. Will always be set to 0.                                                                                                                                     |

## **Clear Status Register**

The status register content can be cleared by CLEAR STATUS REGISTER command (71h). The CLEAR STATUS REGISTER command clears the status register bits SR[6:1]. SR7 remains at 0, which indicates the device is busy.

However, for buffer program abort only, the CLEAR STATUS REGISTER command would change also SR7 to 1, which reverts the device to main array read mode. The status register can also be cleared by using RESET Command (F0h).

## Lock Register

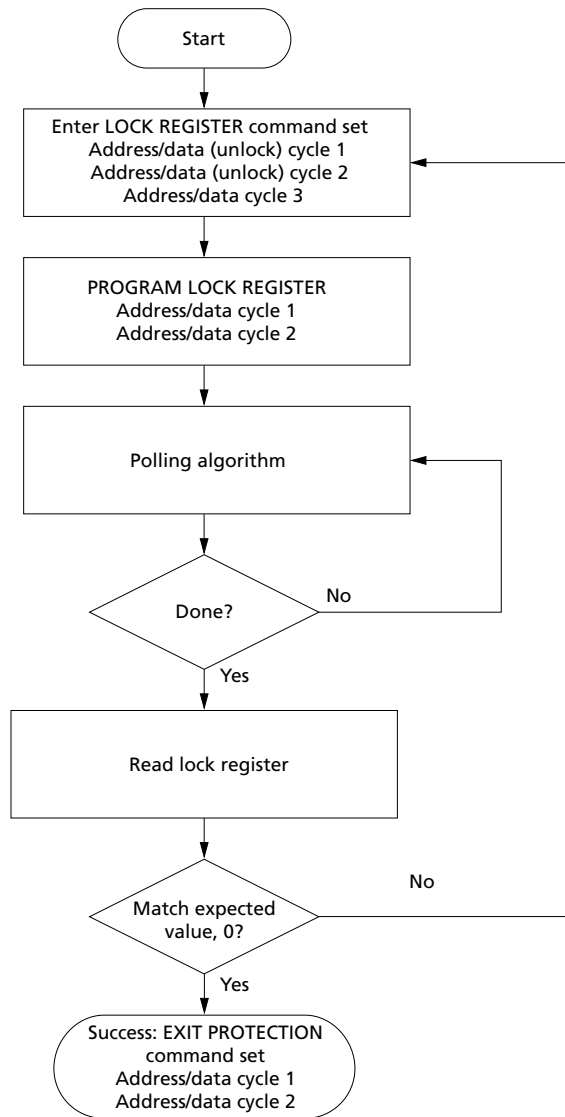
**Table 7: Lock Register Bit Definitions**

Note 1 applies to entire table

| Bit      | Name                                 | Settings                                                                                                                                        | Description                                                                                                                                                                                                                           | Notes |
|----------|--------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
| DQ[15:9] | –                                    | Default value = 1                                                                                                                               | DQ[15:9] are reserved and are set to a default value of 1.                                                                                                                                                                            |       |
| DQ8      | –                                    | Default value = 0                                                                                                                               | DQ8 is reserved and is set to a default value of 0.                                                                                                                                                                                   |       |
| DQ[7:3]  | –                                    | Default value = 1                                                                                                                               | DQ[7:3] are reserved and are set to a default value of 1.                                                                                                                                                                             |       |
| DQ2      | Password protection mode lock bit    | 0 = Password protection mode enabled<br>1 = Password protection mode disabled (default)                                                         | Places the device permanently in password protection mode.                                                                                                                                                                            | 2     |
| DQ1      | Nonvolatile protection mode lock bit | 0 = Nonvolatile protection mode enabled with password protection mode permanently disabled<br>1 = Nonvolatile protection mode enabled (default) | Places the device in nonvolatile protection mode, with password protection mode permanently disabled. When shipped from the factory, the device will operate in nonvolatile protection mode, and the memory blocks are unprotected.   | 2     |
| DQ0      | Extended memory block protection bit | 0 = Protected<br>1 = Unprotected (default)                                                                                                      | If the device is shipped with the extended memory block unlocked, the block can be protected by setting this bit to 0. The extended memory block protection status can be read in auto select mode by issuing an AUTO SELECT command. |       |

- Notes:
1. The lock register is a 16-bit, one-time programmable register. DQ[15:3] are reserved.
  2. The password protection mode lock bit and nonvolatile protection mode lock bit cannot both be programmed to 0. Any attempt to program one while the other is programmed causes the operation to abort, and the device returns to read mode. The device is shipped from the factory with the default setting.

**Figure 8: Lock Register Program Flowchart**



- Notes:
1. Each lock register bit can be programmed only once.
  2. See the Block Protection Command Definitions table for address-data cycle details.
  3. DQ5 and DQ1 are ignored in this algorithm flow.

## Standard Command Definitions – Address-Data Cycles

**Table 8: Standard Command Definitions – Address-Data Cycles**

Note 1 applies to entire table

| Command and Code/Subcode                    | Address and Data Cycles |    |     |    |     |    |        |        |     |    |     |      | Notes   |
|---------------------------------------------|-------------------------|----|-----|----|-----|----|--------|--------|-----|----|-----|------|---------|
|                                             | 1st                     |    | 2nd |    | 3rd |    | 4th    |        | 5th |    | 6th |      |         |
|                                             | A                       | D  | A   | D  | A   | D  | A      | D      | A   | D  | A   | D    |         |
| READ and AUTO SELECT Operations             |                         |    |     |    |     |    |        |        |     |    |     |      |         |
| READ/RESET (F0h)                            | 555                     | AA | 2AA | 55 | X   | F0 |        |        |     |    |     |      | 2       |
| READ CFI (98h)                              | 555                     | 98 |     |    |     |    |        |        |     |    |     |      |         |
| EXIT READ CFI (F0h)                         | X                       | F0 |     |    |     |    |        |        |     |    |     |      |         |
| AUTO SELECT (90h)                           | 555                     | AA | 2AA | 55 | 555 | 90 | Note 3 | Note 3 |     |    |     | 4, 5 |         |
| EXIT AUTO SELECT (F0h)                      | X                       | F0 |     |    |     |    |        |        |     |    |     |      |         |
| READ STATUS (70h)                           | 555                     | 70 |     |    |     |    |        |        |     |    |     |      |         |
| CLEAR STATUS (71h)                          | 555                     | 71 |     |    |     |    |        |        |     |    |     |      |         |
| BYPASS Operations                           |                         |    |     |    |     |    |        |        |     |    |     |      |         |
| UNLOCK BYPASS (20h)                         | 555                     | AA | 2AA | 55 | 555 | 20 |        |        |     |    |     |      |         |
| UNLOCK BYPASS RESET (90h/00h)               | X                       | 90 | X   | 00 |     |    |        |        |     |    |     |      |         |
| PROGRAM Operations                          |                         |    |     |    |     |    |        |        |     |    |     |      |         |
| PROGRAM (A0h)                               | 555                     | AA | 2AA | 55 | 555 | A0 | PA     | PD     |     |    |     |      |         |
| UNLOCK BYPASS PROGRAM (A0h)                 | X                       | A0 | PA  | PD |     |    |        |        |     |    |     | 6    |         |
| WRITE TO BUFFER PROGRAM (25h)               | 555                     | AA | 2AA | 55 | BAd | 25 | BAd    | N      | PA  | PD |     |      | 7, 8, 9 |
| UNLOCK BYPASS WRITE TO BUFFER PROGRAM (25h) | BAd                     | 25 | BAd | N  | PA  | PD |        |        |     |    |     |      | 6       |
| WRITE TO BUFFER PROGRAM CONFIRM (29h)       | BAd                     | 29 |     |    |     |    |        |        |     |    |     | 7    |         |
| BUFFERED PROGRAM ABORT and RESET (F0h)      | 555                     | AA | 2AA | 55 | 555 | F0 |        |        |     |    |     |      |         |
| PROGRAM SUSPEND (B0h)                       | X                       | B0 |     |    |     |    |        |        |     |    |     |      |         |
| PROGRAM RESUME (30h)                        | X                       | 30 |     |    |     |    |        |        |     |    |     |      |         |
| PROGRAM SUSPEND (51h)                       | X                       | 51 |     |    |     |    |        |        |     |    |     |      |         |
| PROGRAM RESUME (50h)                        | X                       | 50 |     |    |     |    |        |        |     |    |     |      |         |
| ERASE Operations                            |                         |    |     |    |     |    |        |        |     |    |     |      |         |
| CHIP ERASE (80/10h)                         | 555                     | AA | 2AA | 55 | 555 | 80 | 555    | AA     | 2AA | 55 | 555 | 10   |         |
| UNLOCK BYPASS CHIP ERASE (80/10h)           | X                       | 80 | X   | 10 |     |    |        |        |     |    |     | 6    |         |

**Table 8: Standard Command Definitions – Address-Data Cycles (Continued)**

Note 1 applies to entire table

| Command and Code/Subcode              | Address and Data Cycles |    |     |    |     |    |     |    |     |    |     |    | Notes |
|---------------------------------------|-------------------------|----|-----|----|-----|----|-----|----|-----|----|-----|----|-------|
|                                       | 1st                     |    | 2nd |    | 3rd |    | 4th |    | 5th |    | 6th |    |       |
|                                       | A                       | D  | A   | D  | A   | D  | A   | D  | A   | D  | A   | D  |       |
| BLOCK ERASE (80/30h)                  | 555                     | AA | 2AA | 55 | 555 | 80 | 555 | AA | 2AA | 55 | BAd | 30 |       |
| UNLOCK BYPASS<br>BLOCK ERASE (80/30h) | X                       | 80 | BAd | 30 |     |    |     |    |     |    |     |    | 6     |
| ERASE SUSPEND (B0h)                   | X                       | B0 |     |    |     |    |     |    |     |    |     |    |       |
| ERASE RESUME (30h)                    | X                       | 30 |     |    |     |    |     |    |     |    |     |    |       |
| BLANK CHECK Operations                |                         |    |     |    |     |    |     |    |     |    |     |    |       |
| BLANK CHECK                           | 555                     | 33 |     |    |     |    |     |    |     |    |     |    |       |

- Notes:
1. A = Address; D = Data; X = "Don't Care"; BAd = Any address in the block; N = Number of words to be programmed; PA = Program address; PD = Program data; Gray shading = Not applicable. All values in the table are hexadecimal. Some commands require both a command code and subcode.
  2. A full three-cycle RESET command sequence must be used to reset the device in the event of a buffered program abort error (DQ1 = 1).
  3. These cells represent READ cycles (versus WRITE cycles for the others).
  4. AUTO SELECT enables the device to read the manufacturer code, device code, block protection status, and extended memory block protection indicator.
  5. AUTO SELECT addresses and data are specified in the Electronic Signature table and the Extended Memory Block Protection table.
  6. For any UNLOCK BYPASS ERASE/PROGRAM command, the first two UNLOCK cycles are unnecessary.
  7. BAd must be the same as the address loaded during the WRITE TO BUFFER PROGRAM 3rd and 4th cycles.
  8. WRITE TO BUFFER PROGRAM operation: maximum cycles = 517. UNLOCK BYPASS WRITE TO BUFFER PROGRAM operation: maximum cycles = 515. WRITE TO BUFFER PROGRAM operation: N + 1 = words to be programmed; maximum buffer size = 512 words.
  9. A[MAX:9] address pins should remain unchanged while A[8:0] pins are used to select a word within the N+1 word page.

## **READ and AUTO SELECT Operations**

### **READ/RESET Command**

The READ/RESET (F0h) command returns the device to read mode and resets the errors in the data polling register. One or three bus WRITE operations can be used to issue the READ/RESET command. Note: A full three-cycle RESET command sequence must be used to reset the device in the event of a buffered program abort error (DQ1 = 1).

Once a PROGRAM, ERASE, or SUSPEND operation begins, RESET commands are ignored until the operation is complete. Read/reset serves primarily to return the device to read mode from a failed PROGRAM or ERASE operation. Read/reset may cause a return to read mode from undefined states that might result from invalid command sequences. A hardware reset may be required to return to normal operation from some undefined states.

To exit the unlock bypass mode, the system must issue a two-cycle UNLOCK BYPASS RESET command sequence. A READ/RESET command will not exit unlock bypass mode.

### **READ CFI Command**

The READ CFI (98h) command puts the device in read CFI mode and is only valid when the device is in read array or auto select mode. One bus WRITE cycle is required to issue the command.

Once in read CFI mode, bus READ operations will output data from the CFI memory area (Refer to the Common Flash Interface for details).

Read CFI mode is exited by performing a READ/RESET command (F0h). The device returns to read mode unless it entered read CFI mode after an ERASE SUSPEND or PROGRAM SUSPEND command, in which case it returns to erase or program suspend mode.

### **AUTO SELECT Command**

At power-up or after a hardware reset, the device is in read mode. It can then be put in auto select mode by issuing an AUTO SELECT (90h) command. Auto select mode enables the following device information to be read:

- Electronic signature, which includes manufacturer and device code information as shown in the Electronic Signature table.
- Block protection, which includes the block protection status and extended memory block protection indicator, as shown in the Block Protection table.

Electronic signature or block protection information is read by executing a READ operation with control signals and addresses set, as shown in the Read Electronic Signature table or the Block Protection table, respectively. In addition, this device information can be read or set by issuing an AUTO SELECT command.

Auto select mode can be used by the programming equipment to automatically match a device with the application code to be programmed.

Three consecutive bus WRITE operations are required to issue an AUTO SELECT command. The device remains in auto select mode until a READ/RESET or READ CFI command is issued.

The device cannot enter auto select mode when a PROGRAM or ERASE operation is in progress (RY/BY# LOW). However, auto select mode can be entered if the PROGRAM or ERASE operation has been suspended by issuing a PROGRAM SUSPEND or ERASE SUSPEND command.

Auto select mode is exited by performing a READ/RESET command (F0h). The device returns to read mode unless it entered auto select mode after an ERASE SUSPEND or PROGRAM SUSPEND command, in which case it returns to erase or program suspend mode.

**Table 9: Block Protection**

Note 1 applies to entire table

| READ Cycle                                                                            | CE# | OE# | WE# | Address Input      |         |    |    | Data Input/Output  |
|---------------------------------------------------------------------------------------|-----|-----|-----|--------------------|---------|----|----|--------------------|
|                                                                                       |     |     |     | A[MAX:16]          | A[15:2] | A1 | A0 | DQ[15:0]           |
| 128-bit (0x0~0x7) Factory-Programmable Extended Memory Protection Indicator (Bit DQ7) |     |     |     |                    |         |    |    |                    |
| Low lock                                                                              | L   | L   | H   | L                  | L       | H  | H  | 0009h <sup>2</sup> |
|                                                                                       |     |     |     |                    |         |    |    | 0089h <sup>3</sup> |
| High lock                                                                             | L   | L   | H   | L                  | L       | H  | H  | 0019h <sup>2</sup> |
|                                                                                       |     |     |     |                    |         |    |    | 0099h <sup>3</sup> |
| Block protection status                                                               |     |     |     |                    |         |    |    |                    |
| Protected                                                                             | L   | L   | H   | Block base address | L       | H  | L  | 0001h              |
| Unprotected                                                                           | L   | L   | H   |                    | L       | H  | L  | 0000h              |

- Notes: 1. H = Logic level HIGH ( $V_{IH}$ ); L = Logic level LOW ( $V_{IL}$ ); X = HIGH or LOW.  
2. Customer-lockable (default).  
3. Micron prelocked.

## Read Electronic Signature

**Table 10: Read Electronic Signature – 1Gb**

Note 1 applies to entire table

| READ Cycle        | CE# | OE# | WE# | Address Input |    |    |    |    | Data Input/Output |
|-------------------|-----|-----|-----|---------------|----|----|----|----|-------------------|
|                   |     |     |     | A[MAX:4]      | A3 | A2 | A1 | A0 | DQ[15:0]          |
| Manufacturer code | L   | L   | H   | L             | L  | L  | L  | L  | 0089h             |
| Device code 1     | L   | L   | H   | L             | L  | L  | L  | H  | 227Eh             |
| Device code 2     | L   | L   | H   | L             | H  | H  | H  | L  | 2228h             |
| Device code 3     | L   | L   | H   | L             | H  | H  | H  | H  | 2201h             |

- Note: 1. H = Logic level HIGH ( $V_{IH}$ ); L = Logic level LOW ( $V_{IL}$ ); X = HIGH or LOW.

## Cyclic Redundancy Check Operation

### CYCLIC REDUNDANCY CHECK Command

The CYCLIC REDUNDANCY CHECK (CRC) command is a nonsecure hash function designed to detect accidental changes to raw data. Typically, it is used in digital networks and storage devices such as hard disk drives. A CRC-enabled device calculates a short, fixed-length binary sequence known as the CRC code (or CRC). The device CRC operation will generate the CRC result of the whole device or of an address range specified by the operation. Then the CRC result is compared with the expected CRC data provided in the sequence. Finally, the device indicates a pass or fail through the data polling register. If the CRC fails, corrective action is possible, such as re-verifying with a normal READ mode or rewriting the array data.

CRC is a higher performance alternative to reading data directly to verify recently programmed data, or as a way to periodically check the data integrity of a large block of data against a stored CRC reference over the life of the product.

CRC helps improve test efficiency for programmer or burn-in stress tests. No system hardware changes are required to enable CRC.

The CRC-64 operation follows the ECMA standard; the generating polynomial is:

$$G(x) = x^{64} + x^{62} + x^{57} + x^{55} + x^{54} + x^{53} + x^{52} + x^{47} + x^{46} + x^{45} + x^{40} + x^{39} + x^{38} + x^{37} + x^{35} + x^{33} + x^{32} + x^{31} + x^{29} + x^{27} + x^{24} + x^{23} + x^{22} + x^{21} + x^{19} + x^{17} + x^{13} + x^{12} + x^{10} + x^9 + x^7 + x^4 + x + 1$$

**Note:** The data stream sequence is from LSB to MSB and the default initial CRC value is all zeros.

The CRC command sequences are shown in the tables below, for an entire die or for a selected range, respectively.

### Cyclic Redundancy Check Operation Command Sequence

**Table 11: Command Sequence – Range of Blocks**

Note 1 and 2 apply to entire table.

| Address | DQ[15:0] | Description                         | Notes |
|---------|----------|-------------------------------------|-------|
| 0000555 | 00AAh    | UI unlock cycle 1                   |       |
| 00002AA | 0055h    | UI unlock cycle 2                   |       |
| 0000000 | 00EBh    | Extended function interface command |       |
| 0000000 | 0027h    | CRC sub-op code                     |       |
| 0000000 | 000Ah    | N-1 data count                      |       |
| 0000000 | FFFEh    | CRC operation option data           |       |
| 0000001 | Data     | 1st word of 64-bit expected CRC     |       |
| 0000002 | Data     | 2nd word of 64-bit expected CRC     |       |
| 0000003 | Data     | 3rd word of 64-bit expected CRC     |       |
| 0000004 | Data     | 4th word of 64-bit expected CRC     |       |

**Table 11: Command Sequence – Range of Blocks (Continued)**

Note 1 and 2 apply to entire table.

| Address | DQ[15:0]                                                                     | Description                                          | Notes |
|---------|------------------------------------------------------------------------------|------------------------------------------------------|-------|
| 0000005 | DQ15 = A14<br>DQ14 = A13<br>...<br>DQ2 = A1<br>DQ1 = A0<br>DQ0 = set to zero | Byte address to start                                | 3     |
| 0000006 | A <sub>30</sub> -A <sub>15</sub>                                             | Byte address to start                                | 3     |
| 0000007 | Reserved                                                                     | Default as 0000h                                     |       |
| 0000008 | DQ15 = A14<br>DQ14 = A13<br>...<br>DQ2 = A1<br>DQ1 = A0<br>DQ0 = set to zero | Byte address to stop                                 | 3     |
| 0000009 | A <sub>30</sub> -A <sub>15</sub>                                             | Byte address to stop                                 | 3     |
| 000000A | Reserved                                                                     | Default as 0000h                                     |       |
| 0000000 | 0029h                                                                        | Confirm command                                      |       |
| 0000000 | Read                                                                         | Continue data polling to wait for device to be ready |       |

- Notes:
1. If the CRC check fails, a check error is generated by setting DQ5 = 1.
  2. This is a byte-aligned operation.
  3. The stop address must be bigger than the start address; otherwise, the algorithm will take no action.

**Table 12: Command Sequence – Entire Chip**

| Address | DQ[15:0] | Description                                          |
|---------|----------|------------------------------------------------------|
| 0000555 | 00AAh    | UI unlock cycle 1                                    |
| 00002AA | 0055h    | UI unlock cycle 2                                    |
| 0000000 | 00EBh    | Extended function interface command                  |
| 0000000 | 0027h    | CRC sub-op code                                      |
| 0000000 | 0004h    | N-1 data count                                       |
| 0000000 | FFFFh    | CRC operation option data                            |
| 0000001 | Data     | 1st word of 64-bit expected CRC                      |
| 0000002 | Data     | 2nd word of 64-bit expected CRC                      |
| 0000003 | Data     | 3rd word of 64-bit expected CRC                      |
| 0000004 | Data     | 4th word of 64-bit expected CRC                      |
| 0000000 | 0029h    | Confirm command                                      |
| 0000000 | Read     | Continue data polling to wait for device to be ready |

Note: 1. Applies to entire table: If the CRC check fails, a check error is generated by setting DQ5 = 1.

## Bypass Operations

### UNLOCK BYPASS Command

The UNLOCK BYPASS (20h) command is used to place the device in unlock bypass mode. Three bus WRITE operations are required to issue the UNLOCK BYPASS command.

When the device enters unlock bypass mode, the two initial UNLOCK cycles required for a standard PROGRAM or ERASE operation are not needed, thus enabling faster total program or erase time.

The UNLOCK BYPASS command is used in conjunction with UNLOCK BYPASS PROGRAM or UNLOCK BYPASS ERASE commands to program or erase the device faster than with standard PROGRAM or ERASE commands. Using these commands can save considerable time when the cycle time to the device is long. When in unlock bypass mode, only the following commands are valid:

- The UNLOCK BYPASS PROGRAM command can be issued to program addresses within the device.
- The UNLOCK BYPASS BLOCK ERASE command can then be issued to erase one or more memory blocks.
- The UNLOCK BYPASS CHIP ERASE command can be issued to erase the whole memory array.
- The UNLOCK BYPASS WRITE TO BUFFER PROGRAM and UNLOCK BYPASS ENHANCED WRITE TO BUFFER PROGRAM commands can be issued to speed up the programming operation.
- The UNLOCK BYPASS RESET command can be issued to return the device to read mode.

In unlock bypass mode, the device can be read as if in read mode.

In addition to the UNLOCK BYPASS command, when  $V_{PP}/WP\#$  is raised to  $V_{HH}$ , the device automatically enters unlock bypass mode. When  $V_{PP}/WP\#$  returns to  $V_{IH}$  or  $V_{IL}$ , the device is no longer in unlock bypass mode, and normal operation resumes. The transitions from  $V_{IH}$  to  $V_{HH}$  and from  $V_{HH}$  to  $V_{IH}$  must be slower than  $t_{VHVPP}$ . (See the Accelerated Program, Data Polling/Toggle AC Characteristics.)

**Note:** Micron recommends entering and exiting unlock bypass mode using the ENTER UNLOCK BYPASS and UNLOCK BYPASS RESET commands rather than raising  $V_{PP}/WP\#$  to  $V_{HH}$ .  $V_{PP}/WP\#$  should never be raised to  $V_{PPH}$  from any mode except read mode; otherwise, the device may be left in an indeterminate state.  $V_{PP}/WP\#$  should not remain at  $V_{HH}$  for than 80 hours cumulative.

### UNLOCK BYPASS RESET Command

The UNLOCK BYPASS RESET (90/00h) command is used to return to read/reset mode from unlock bypass mode. Two bus WRITE operations are required to issue the UNLOCK BYPASS RESET command. The READ/RESET command does not exit from unlock bypass mode.

## Program Operations

### PROGRAM Command

The PROGRAM (A0h) command can be used to program a value to one address in the memory array. The command requires four bus WRITE operations, and the final WRITE operation latches the address and data in the internal state machine and starts the program/erase controller. After programming has started, bus READ operations output the data polling register content.

Programming can be suspended and then resumed by issuing a PROGRAM SUSPEND command and a PROGRAM RESUME command, respectively.

If the address falls in a protected block, the PROGRAM command is ignored, and the data remains unchanged. The data polling register is not read, and no error condition is given.

After the PROGRAM operation has completed, the device returns to read mode, unless an error has occurred. When an error occurs, bus READ operations to the device continue to output the data polling register. A READ/RESET command must be issued to reset the error condition and return the device to read mode.

The PROGRAM command cannot change a bit set to 0 back to 1, and an attempt to do so is masked during a PROGRAM operation. Instead, an ERASE command must be used to set all bits in one memory block or in the entire memory from 0 to 1.

The PROGRAM operation is aborted by performing a hardware reset or by powering down the device. In this case, data integrity cannot be ensured, and it is recommended that the words or bytes that were aborted be reprogrammed.

### UNLOCK BYPASS PROGRAM Command

When the device is in unlock bypass mode, the UNLOCK BYPASS PROGRAM (A0h) command can be used to program one address in the memory array. The command requires two bus WRITE operations instead of four required by a standard PROGRAM command; the final WRITE operation latches the address and data and starts the program/erase controller (The standard PROGRAM command requires four bus WRITE operations). The PROGRAM operation using the UNLOCK BYPASS PROGRAM command behaves identically to the PROGRAM operation using the PROGRAM command. The operation cannot be aborted. A bus READ operation to the memory outputs the data polling register.

### WRITE TO BUFFER PROGRAM Command

The WRITE TO BUFFER PROGRAM (25h) command makes use of the program buffer to speed up programming and dramatically reduces system programming time compared to the standard non-buffered PROGRAM command. This product supports a 512-word maximum program buffer.

When issuing a WRITE TO BUFFER PROGRAM command,  $V_{pp}/WP\#$  can be held HIGH or raised to  $V_{HH}$ . Also, it can be held LOW if the block is not the lowest or highest block, depending on the part number.

The following successive steps are required to issue the WRITE TO BUFFER PROGRAM command:

First, two UNLOCK cycles are issued. Next, a third bus WRITE cycle sets up the WRITE TO BUFFER PROGRAM command. The set-up code can be addressed to any location within the targeted block. Then, a fourth bus WRITE cycle sets up the number of words to be programmed. Value  $n$  is written to the same block address, where  $n + 1$  is the number of words to be programmed. Value  $n + 1$  must not exceed the size of the program buffer, or the operation will abort. A fifth cycle loads the first address and data to be programmed. Last,  $n$  bus WRITE cycles load the address and data for each word into the program buffer. Addresses must lie within the range from *the start address + 1* to *the start address + (n - 1)*.

Optimum programming performance and lower power usage are achieved by aligning the starting address at the beginning of a 512-word boundary ( $A[8:0] = 0x000h$ ). Any buffer size smaller than 512 words is allowed within a 512-word boundary, while all addresses used in the operation must lie within the 512-word boundary. In addition, any crossing boundary buffer program will result in a program abort.

To program the content of the program buffer, this command must be followed by a WRITE TO BUFFER PROGRAM CONFIRM command.

If an address is written several times during a WRITE TO BUFFER PROGRAM operation, the address/data counter will be decremented at each data load operation, and the data will be programmed to the last word loaded into the buffer.

Invalid address combinations or the incorrect sequence of bus WRITE cycles will abort the WRITE TO BUFFER PROGRAM command.

The data polling register bits DQ1, DQ5, DQ6, DQ7 can be used to monitor the device status during a WRITE TO BUFFER PROGRAM operation.

The WRITE TO BUFFER PROGRAM command should not be used to change a bit set to 0 back to 1, and an attempt to do so is masked during the operation. Rather than the WRITE TO BUFFER PROGRAM command, the ERASE command should be used to set memory bits from 0 to 1.

**Figure 9: Boundary Condition of Program Buffer Size**

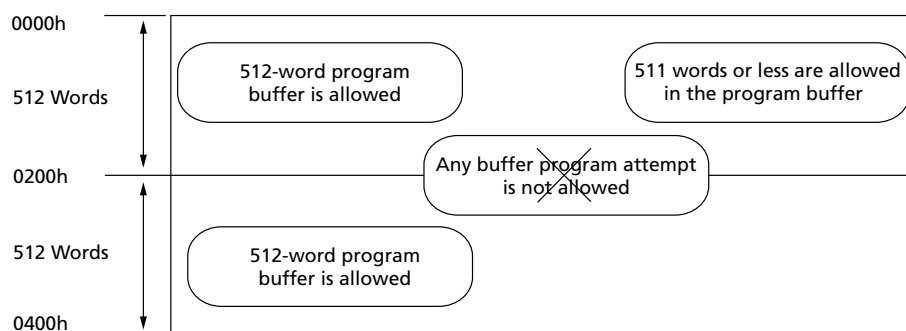
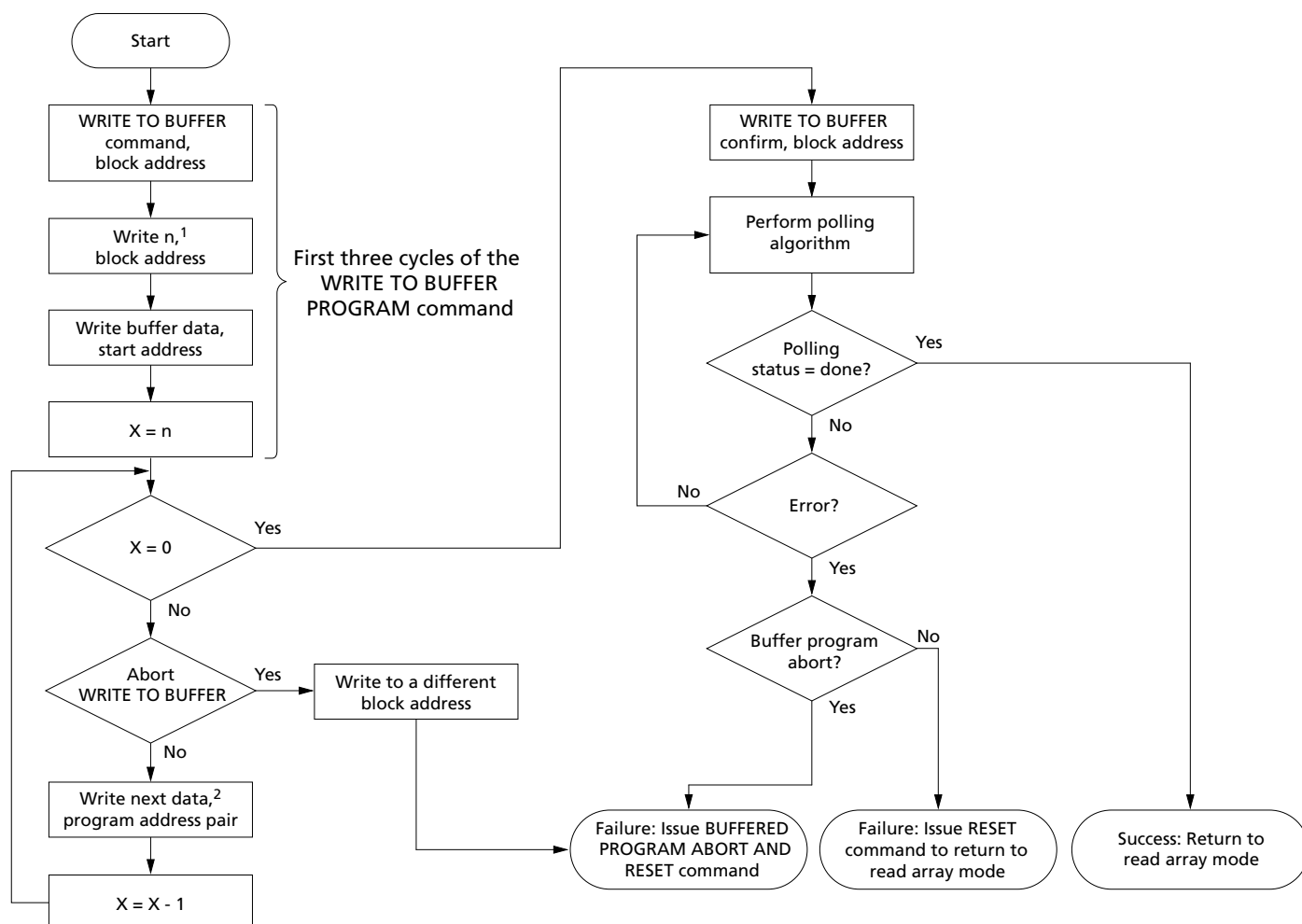


**Figure 10: WRITE TO BUFFER PROGRAM Flowchart**



- Notes:
1.  $n + 1$  is the number of addresses to be programmed.
  2. The BUFFERED PROGRAM ABORT AND RESET command (3 cycles reset) must be issued to return the device to read mode.
  3. When the block address is specified, any address in the selected block address space is acceptable. However, when loading program buffer address with data, all addresses must fall within the selected program buffer page.

## **UNLOCK BYPASS WRITE TO BUFFER PROGRAM Command**

When the device is in unlock bypass mode, the UNLOCK BYPASS WRITE TO BUFFER (25h) command can be used to program the device in fast program mode. The command requires two bus WRITE operations fewer than the standard WRITE TO BUFFER PROGRAM command.

The UNLOCK BYPASS WRITE TO BUFFER PROGRAM command behaves the same way as the WRITE TO BUFFER PROGRAM command: the operation cannot be aborted, and a bus READ operation to the memory outputs the data polling register.

The WRITE TO BUFFER PROGRAM CONFIRM command is used to confirm an UNLOCK BYPASS WRITE TO BUFFER PROGRAM command and to program the  $n + 1$  words loaded in the program buffer by this command.

## **WRITE TO BUFFER PROGRAM CONFIRM Command**

The WRITE TO BUFFER PROGRAM CONFIRM (29h) command is used to confirm a WRITE TO BUFFER PROGRAM command and to program the  $n + 1$  words loaded in the program buffer by this command.

## **BUFFERED PROGRAM ABORT AND RESET Command**

A BUFFERED PROGRAM ABORT AND RESET (F0h) command must be issued to reset the device to read mode when the BUFFER PROGRAM operation is aborted. The buffer programming sequence can be aborted in the following ways:

- Load a value that is greater than the page buffer size during the number of locations to program in the WRITE TO BUFFER PROGRAM command.
- Write to an address in a different block than the one specified during the WRITE BUFFER LOAD command.
- Write an address/data pair to a different write buffer page than the one selected by the starting address during the program buffer data loading stage of the operation.
- Write data other than the CONFIRM command after the specified number of data load cycles.

The abort condition is indicated by  $DQ1 = 1$ ,  $DQ7 = DQ7\#$  (for the last address location loaded),  $DQ6 = \text{toggle}$ , and  $DQ5 = 0$  (all of which are data polling register bits). A BUFFERED PROGRAM ABORT and RESET command sequence must be written to reset the device for the next operation.

**Note:** The full three-cycle BUFFERED PROGRAM ABORT and RESET command sequence is required when using buffer programming features in unlock bypass mode.

## **PROGRAM SUSPEND Command**

The PROGRAM SUSPEND command can be used to interrupt a program operation so that data can be read from another block. When the PROGRAM SUSPEND command is issued during a program operation, the device suspends the operation within the program suspend latency time and updates the data polling register bits.

After the PROGRAM operation has been suspended, data can be read from any address. However, data is invalid when read from an address where a program operation has been suspended.

The PROGRAM SUSPEND command may also be issued during a PROGRAM operation while an erase is suspended. In this case, data may be read from any address not in erase suspend or program suspend mode. To read from the extended memory block area (one-time programmable area), the ENTER/EXIT EXTENDED MEMORY BLOCK command sequences must be issued.

The system may also issue the AUTO SELECT command sequence when the device is in program suspend mode. The system can read as many auto select codes as required. When the device exits auto select mode, the device reverts to program suspend mode and is ready for another valid operation.

The PROGRAM SUSPEND operation is aborted by performing a device reset or power-down. In this case, data integrity cannot be ensured, and it is recommended that the words that were aborted be reprogrammed. This device has two different command codes for program suspend, B0h and 51h. Code B0h is available for legacy compatibility. Code 51h is recommended for use.

## PROGRAM RESUME Command

The PROGRAM RESUME command must be issued to exit a program suspend mode and resume a PROGRAM operation. The controller can use DQ7 or DQ6 data polling bits to determine the status of the PROGRAM operation. After a PROGRAM RESUME command is issued, subsequent PROGRAM RESUME commands are ignored. Another PROGRAM SUSPEND command can be issued after the device has resumed programming. This device has two different command codes for Program Resume (30h or 50h). Code 30h is available for legacy compatibility. Code 50h is recommended to use.

## ACCELERATED BUFFERED PROGRAM Operations

ACCELERATED BUFFER PROGRAM operations provides faster performance than standard program command sequences. Operations are enabled through  $V_{PP}/WP\#$  under the  $V_{HH}$  voltage supply.

When the system asserts  $V_{HH}$  on input, the device automatically enters the UNLOCK BYPASS mode, which enables the system to use the UNLOCK BYPASS WRITE TO BUFFER PROGRAM (25h) command sequence.

Removing  $V_{HH}$  from the  $V_{PP}$  upon completion of the embedded program operation returns the device to normal operation.

**Table 13: ACCELERATED PROGRAM Requirements and Recommendations**

| Device State                      | Requirements/Recommendations                                                                                                                                                                                                                   |
|-----------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Device blocks                     | <b>Requirement:</b> Must be unprotected prior to raising $V_{PP}/WP\#$ to $V_{HH}$                                                                                                                                                             |
| $V_{HH}$ applied to $V_{PP}/WP\#$ | <b>Requirement:</b> Maximum cumulative period of 80 hours.                                                                                                                                                                                     |
| $V_{PP}/WP\#$                     | <b>Requirement:</b> Must not be at $V_{HH}$ for operations except ACCELERATED BUFFERED PROGRAM and CHIP ERASE; otherwise device can be damaged<br><b>Recommendation:</b> Keep stable to $V_{HH}$ during ACCELERATED BUFFERED PROGRAM operation |
| Power-up                          | <b>Recommendation:</b> Apply $V_{HH}$ on $V_{PP}/WP\#$ after $V_{CC}/V_{CCQ}$ is stable on.                                                                                                                                                    |
| Power-down                        | <b>Recommendation:</b> Adjust $V_{PP}/WP\#$ from $V_{HH}$ to $V_{IH}/V_{IL}$ before $V_{CC}/V_{CCQ}$ goes LOW.                                                                                                                                 |

## Erase Operations

### CHIP ERASE Command

The CHIP ERASE (80/10h) command erases the entire chip. Six bus WRITE operations are required to issue the command and start the program/erase controller.

Protected blocks are not erased. If all blocks are protected, the data remains unchanged. No error is reported when protected blocks are not erased.

During the CHIP ERASE operation, the device ignores all other commands, including ERASE SUSPEND. It is not possible to abort the operation. All bus READ operations during CHIP ERASE output the data polling register on the data I/Os. See the Data Polling Register section for more details.

After the CHIP ERASE operation completes, the device returns to read mode, unless an error has occurred. If an error occurs, the device will continue to output the data polling register.

When the operation fails, a READ/RESET command must be issued to reset the error condition and return to read mode. The status of the array must be confirmed through the BLANK CHECK operation and the BLOCK ERASE command re-issued to the failed block.

The CHIP ERASE command sets all of the bits in unprotected blocks of the device to 1. All previous data is lost.

The operation is aborted by performing a reset or by powering down the device. In this case, data integrity cannot be ensured, and it is recommended that the entire chip be erased again.

### UNLOCK BYPASS CHIP ERASE Command

When the device is in unlock bypass mode, the UNLOCK BYPASS CHIP ERASE (80/10h) command can be used to erase all memory blocks at one time. The command requires only two bus WRITE operations instead of six using the standard CHIP ERASE command. The final bus WRITE operation starts the program/erase controller.

The UNLOCK BYPASS CHIP ERASE command behaves the same way as the CHIP ERASE command: the operation cannot be aborted, and a bus READ operation to the memory outputs the data polling register.

### BLOCK ERASE Command

The BLOCK ERASE (80/30h) command erase one block. It sets all bits in the unprotected selected block to 1. All previous data in the selected block are lost. Six bus WRITE operations are required to select the block to be erased.

After the sixth bus WRITE operation, a bus READ operation outputs the data polling register. See the WE#-Controlled Program waveforms for details on how to identify if the program/erase controller has started the BLOCK ERASE operation.

After the BLOCK ERASE operation completes, the device returns to read mode, unless an error has occurred. If an error occurs, bus READ operations will continue to output the data polling register. A READ/RESET command must be issued to reset the error condition and return to read mode.

If the selected block is protected, it is ignored and the data remains unchanged. No error condition is given when protected block is not erased.

During the BLOCK ERASE operation, the device ignores all commands except the ERASE SUSPEND command and the READ STATUS command. The operation is aborted by performing a hardware reset or powering down the device. In this case, data integrity cannot be ensured, and it is recommended that the aborted blocks be erased again.

## **UNLOCK BYPASS BLOCK ERASE Command**

When the device is in unlock bypass mode, the UNLOCK BYPASS BLOCK ERASE (80/30h) command can be used to erase one memory block. The command requires two bus WRITE operations instead of six using the standard BLOCK ERASE command. The final bus WRITE operation latches the address of the block and starts the program/erase controller.

The UNLOCK BYPASS BLOCK ERASE command behaves the same way as the BLOCK ERASE command: the operation cannot be aborted, and a bus READ operation to the memory outputs the data polling register. See the BLOCK ERASE Command section for details.

## **ERASE SUSPEND Command**

The ERASE SUSPEND (B0h) command temporarily suspends a BLOCK ERASE operation. One bus WRITE operation is required to issue the command. The block address is "Don't Care."

The program/erase controller suspends the ERASE operation within the erase suspend latency time of the ERASE SUSPEND command being issued. However, when the ERASE SUSPEND command is written during the block erase timeout, the device immediately terminates the timeout period and suspends the ERASE operation. After the program/erase controller has stopped, the device operates in read mode, and the erase is suspended.

During an ERASE SUSPEND operation, it is possible to execute these operations in arrays that are not suspended:

- READ (main memory array)
- PROGRAM
- WRITE TO BUFFER PROGRAM
- AUTO SELECT
- READ CFI
- UNLOCK BYPASS
- Extended memory block commands
- READ/RESET

Reading from a suspended block will output the data polling register. If an attempt is made to program in a protected or suspended block, the PROGRAM command is ignored and the data remains unchanged; also, the data polling register is not read and no error condition is given.

Before the RESUME command is initiated, the READ/RESET command must be issued to exit AUTO SELECT and READ CFI operations. In addition, the EXIT UNLOCK BYPASS

and EXIT EXTENDED MEMORY BLOCK commands must be issued to exit unlock bypass and the extended memory block modes.

An ERASE SUSPEND command is ignored if it is written during a CHIP ERASE operation.

If the ERASE SUSPEND operation is aborted by performing a device hardware reset or power-down, data integrity cannot be ensured, and it is recommended that the suspended blocks be erased again.

## ERASE RESUME Command

The ERASE RESUME (30h) command restarts the program/erase controller after an ERASE SUSPEND operation.

The device must be in read array mode before the RESUME command will be accepted. An erase can be suspended and resumed more than once.

## ACCELERATED CHIP ERASE Operations

The ACCELERATED CHIP ERASE operation provides faster performance than the standard CHIP ERASE command sequence. Operations are enabled through  $V_{PP}/WP\#$  under the  $V_{HH}$  voltage supply.

When the system asserts  $V_{HH}$  on input, the device automatically enters the UNLOCK BYPASS mode, which enables the system to use the UNLOCK BYPASS CHIP ERASE (80/30h) command sequence.

When a block is protected, the CHIP ERASE command skips the protected block and continues with next block erase. The command algorithm skips a block that failed to erase and continues with the remaining blocks. The fail flag will be set for the operation.

Removing  $V_{HH}$  from the  $V_{PP}/WP\#$  upon completion of the embedded erase operation returns the device to normal operation. When an error occurs or when the operation fails, the array status should be confirmed through the BLANK CHECK operation and the BLOCK ERASE command re-issued to the failed block.

**Table 14: ACCELERATED CHIP ERASE Requirements and Recommendations**

| Device Component/State            | Requirements/Recommendations                                                                                                           |
|-----------------------------------|----------------------------------------------------------------------------------------------------------------------------------------|
| $V_{PP}/WP\#$                     | <b>Requirement:</b> Must not be at $V_{HH}$ for operations except ACCELERATED PROGRAM and CHIP ERASE; otherwise device can be damaged. |
| $V_{HH}$ applied to $V_{PP}/WP\#$ | <b>Requirement:</b> Maximum cumulative period of 80 hours.                                                                             |
| Power-up                          | <b>Recommendation:</b> Apply $V_{HH}$ on $V_{PP}/WP\#$ after $V_{CC}/V_{CCQ}$ is stable on.                                            |
| Power-down                        | <b>Recommendation:</b> Adjust $V_{PP}/WP\#$ from $V_{HH}$ to $V_{IH}/V_{IL}$ before $V_{CC}/V_{CCQ}$ goes LOW.                         |

## BLANK CHECK Operation

The BLANK CHECK operation determines whether a specified block is blank (that is, completely erased). It can also be used to determine whether a previous ERASE operation was successful, including ERASE operations that might have been interrupted by power loss.

The BLANK CHECK operation checks for cells that are programmed or over-erased. If it finds any, it returns a failure status, indicating that the block is not blank. If it returns a passing status, the block is guaranteed blank (all 1s) and is ready to program.

Before executing, the ERASE operation initiates an embedded BLANK CHECK operation, and if the target block is blank, the ERASE operation is skipped, benefitting overall cycle performance; otherwise, the ERASE operation continues.

The BLANK CHECK operation can occur in only one block at a time, and during its execution, reading the data polling register is the only other operation allowed. Reading from any address in the device enables reading the data polling register to monitor blank check progress or errors. Operations such as READ (array data), PROGRAM, ERASE, and any suspended operation are not allowed.

After the BLANK CHECK operation has completed, the device returns to read mode unless an error has occurred. When an error occurs, the device continues to output data polling register data. A READ/RESET command must be issued to reset the error condition and return the device to read mode.

## Device Protection

### Hardware Protection

The  $V_{PP}/WP\#$  function provides a hardware method of protecting either the highest or lowest block. When  $V_{PP}/WP\#$  is LOW, PROGRAM and ERASE operations on either of these block options is ignored to provide protection. When  $V_{PP}/WP\#$  is HIGH, the device reverts to the previous protection status for the highest or lowest block. PROGRAM and ERASE operations can modify the data in either of these block options unless block protection is enabled.

**Note:** Micron highly recommends driving  $V_{PP}/WP\#$  HIGH or LOW. If a system needs to float the  $V_{PP}/WP\#$  pin, without a pull-up/pull-down resistor and no capacitor, then an internal pull-up resistor is enabled.

**Table 15:  $V_{PP}/WP\#$  Functions**

| $V_{PP}/WP\#$ Settings | Function                                                                        |
|------------------------|---------------------------------------------------------------------------------|
| $V_{IL}$               | Highest or lowest block is protected.                                           |
| $V_{IH}$               | Highest or lowest block is unprotected unless software protection is activated. |

### Software Protection

The following software protection modes are available:

- Volatile protection
- Nonvolatile protection
- Password protection

The device is shipped with all blocks unprotected. On first use, the device defaults to the nonvolatile protection mode but can be activated in either the nonvolatile protection or password protection mode.

The desired protection mode is activated by setting either the nonvolatile protection mode lock bit or the password protection mode lock bit of the lock register (see the Lock Register section). Both bits are one-time-programmable and nonvolatile; therefore, after the protection mode has been activated, it cannot be changed, and the device is set permanently to operate in the selected protection mode. It is recommended that the desired software protection mode be activated when first programming the device.

For the highest or lowest block, a higher level of block protection can be achieved by locking the block using nonvolatile protection mode and holding  $V_{PP}/WP\#$  LOW.

Blocks with volatile protection and nonvolatile protection can coexist within the memory array. If the user attempts to program or erase a protected block, the device ignores the command and returns to read mode.

The block protection status can be read by performing a read electronic signature or by issuing an AUTO SELECT command (see the Block Protection table).

Refer to the Block Protection Status table and the Software Protection Scheme figure for details on the block protection scheme. Refer to the Protection Operations section for a description of the command sets.

## **Volatile Protection Mode**

Volatile protection enables the software application to protect blocks against inadvertent change and can be disabled when changes are needed. Volatile protection bits are unique for each block and can be individually modified. Volatile protection bits control the protection scheme only for unprotected blocks whose nonvolatile protection bits are cleared to 1. Issuing a PROGRAM VOLATILE PROTECTION BIT or CLEAR VOLATILE PROTECTION BIT command sets to 0 or clears to 1 the volatile protection bits and places the associated blocks in the protected (0) or unprotected (1) state, respectively. The volatile protection bit can be set or cleared as often as needed.

When the device is first shipped, or after a power-up or hardware reset, the volatile protection bits default to 1 (unprotected).

## **Nonvolatile Protection Mode**

A nonvolatile protection bit is assigned to each block. Each of these bits can be set for protection individually by issuing a PROGRAM NONVOLATILE PROTECTION BIT command. Also, each device has one global volatile bit called the nonvolatile protection bit lock bit; it can be set to protect all nonvolatile protection bits at once. This global bit must be set to 0 only after all nonvolatile protection bits are configured to the desired settings. When set to 0, the nonvolatile protection bit lock bit prevents changes to the state of the nonvolatile protection bits. When cleared to 1, the nonvolatile protection bits can be set and cleared using the PROGRAM NONVOLATILE PROTECTION BIT and CLEAR ALL NONVOLATILE PROTECTION BITS commands, respectively.

No software command unlocks the nonvolatile protection bit lock bit unless the device is in password protection mode; in nonvolatile protection mode, the nonvolatile protection bit lock bit can be cleared only by taking the device through a hardware reset or power-up.

Nonvolatile protection bits cannot be cleared individually; they must be cleared all at once using a CLEAR ALL NONVOLATILE PROTECTION BITS command. They will remain set through a hardware reset or a power-down/power-up sequence.

If one of the nonvolatile protection bits needs to be cleared (unprotected), additional steps are required: First, the nonvolatile protection bit lock bit must be cleared to 1, using either a power-cycle or hardware reset. Then, the nonvolatile protection bits can be changed to reflect the desired settings. Finally, the nonvolatile protection bit lock bit must be set to 0 to lock the nonvolatile protection bits. The device now will operate normally.

To achieve the best protection, the PROGRAM NONVOLATILE PROTECTION LOCK BIT command should be executed early in the boot code, and the boot code should be protected by holding  $V_{PP}/WP\#$  LOW.

Nonvolatile protection bits and volatile protection bits have the same function when  $V_{PP}/WP\#$  is HIGH or when  $V_{PP}/WP\#$  is at the voltage for program acceleration ( $V_{HH}$ ).

## **Password Protection Mode**

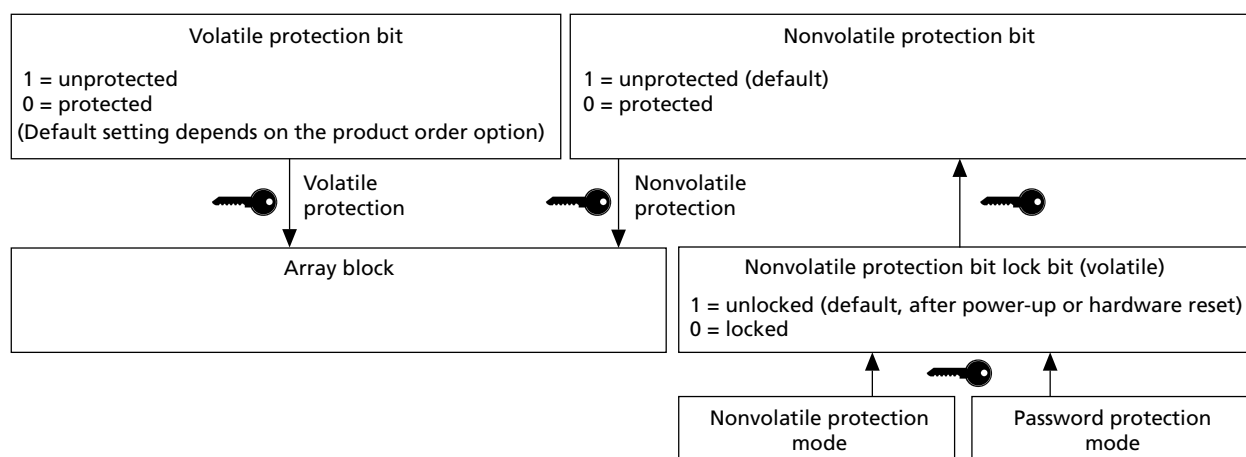
The password protection mode provides a higher level of security than the nonvolatile protection mode by requiring a 64-bit password to unlock the nonvolatile protection bit lock bit. In addition to this password requirement, the nonvolatile protection bit lock bit is set to 0 after power-up and reset to maintain the device in password protection mode.

Executing the UNLOCK PASSWORD command by entering the correct password clears the nonvolatile protection bit lock bit, enabling the block nonvolatile protection bits to be modified. If the password provided is incorrect, the nonvolatile protection bit lock bit remains locked, and the state of the nonvolatile protection bits cannot be modified.

To place the device in password protection mode, the following two steps are required: First, before activating the password protection mode, a 64-bit password must be set and the setting verified. Password verification is allowed only before the password protection mode is activated. Next, password protection mode is activated by programming the password protection mode lock bit to 0. This operation is irreversible. After the bit is programmed, it cannot be erased, the device remains permanently in password protection mode, and the 64-bit password can be neither retrieved nor reprogrammed. In addition, all commands to the address where the password is stored are disabled.

**Note:** There is no means to verify the password after password protection mode is enabled. If the password is lost after enabling the password protection mode, there is no way to clear the nonvolatile protection bit lock bit.

**Figure 11: Software Protection Scheme**



- Notes:
1. Volatile protection bits are programmed and cleared individually. Nonvolatile protection bits are programmed individually and cleared collectively.
  2. Once programmed to 0, the nonvolatile protection bit lock bit can be reset to 1 only by taking the device through a power-up or hardware reset.

**Table 16: Block Protection Status**

| Nonvolatile Protection Bit Lock Bit <sup>1</sup> | Nonvolatile Protection Bit <sup>2</sup> | Volatile Protection Bit <sup>3</sup> | Block Protection Status <sup>4</sup> | Block Protection Status                                                                                             |
|--------------------------------------------------|-----------------------------------------|--------------------------------------|--------------------------------------|---------------------------------------------------------------------------------------------------------------------|
| 1                                                | 1                                       | 1                                    | 00h                                  | Block unprotected; nonvolatile protection bit changeable.                                                           |
| 1                                                | 1                                       | 0                                    | 01h                                  | Block protected by volatile protection bit; nonvolatile protection bit changeable.                                  |
| 1                                                | 0                                       | 1                                    | 01h                                  | Block protected by nonvolatile protection bit; nonvolatile protection bit changeable.                               |
| 1                                                | 0                                       | 0                                    | 01h                                  | Block protected by nonvolatile protection bit and volatile protection bit; nonvolatile protection bit changeable.   |
| 0                                                | 1                                       | 1                                    | 00h                                  | Block unprotected; nonvolatile protection bit unchangeable.                                                         |
| 0                                                | 1                                       | 0                                    | 01h                                  | Block protected by volatile protection bit; nonvolatile protection bit unchangeable.                                |
| 0                                                | 0                                       | 1                                    | 01h                                  | Block protected by nonvolatile protection bit; nonvolatile protection bit unchangeable.                             |
| 0                                                | 0                                       | 0                                    | 01h                                  | Block protected by nonvolatile protection bit and volatile protection bit; nonvolatile protection bit unchangeable. |

- Notes:
1. Nonvolatile protection bit lock bit: when cleared to 1, all nonvolatile protection bits are unlocked; when set to 0, all nonvolatile protection bits are locked.
  2. Block nonvolatile protection bit: when cleared to 1, the block is unprotected; when set to 0, the block is protected.
  3. Block volatile protection bit: when cleared to 1, the block is unprotected; when set to 0, the block is protected.
  4. Block protection status is checked under AUTO SELECT mode.

## Block Protection Command Definitions – Address-Data Cycles

**Table 17: Block Protection Command Definitions – Address-Data Cycles**

Notes 1 and 2 apply to entire table

| Command and Code/Subcode                          | Address and Data Cycles |            |      |      |     |      |     |      |     |     |         | Notes   |
|---------------------------------------------------|-------------------------|------------|------|------|-----|------|-----|------|-----|-----|---------|---------|
|                                                   | 1st                     |            | 2nd  |      | 3rd |      | 4th |      | ... | nth |         |         |
|                                                   | A                       | D          | A    | D    | A   | D    | A   | D    |     | A   | D       |         |
| LOCK REGISTER Commands                            |                         |            |      |      |     |      |     |      |     |     |         |         |
| ENTER LOCK REGISTER<br>COMMAND SET (40h)          | 555                     | AA         | 2AA  | 55   | 555 | 40   |     |      |     |     |         | 3       |
| PROGRAM LOCK REGISTER (A0h)                       | X                       | A0         | X    | Data |     |      |     |      |     |     | 5       |         |
| READ LOCK REGISTER                                | X                       | Data       |      |      |     |      |     |      |     |     | 4, 5, 6 |         |
| EXIT LOCK REGISTER (90h/00h)                      | X                       | 90         | X    | 00   |     |      |     |      |     |     | 3       |         |
| PASSWORD PROTECTION Commands                      |                         |            |      |      |     |      |     |      |     |     |         |         |
| ENTER PASSWORD PROTECTION<br>COMMAND SET (60h)    | 555                     | AA         | 2AA  | 55   | 555 | 60   |     |      |     |     |         | 3       |
| PROGRAM PASSWORD (A0h)                            | X                       | A0         | PWAn | PWDn |     |      |     |      |     |     | 7       |         |
| READ PASSWORD                                     | 00                      | PWD0       | 01   | PWD1 | 02  | PWD2 | 03  | PWD3 |     |     |         | 4, 6, 8 |
| UNLOCK PASSWORD (25h/03h)                         | 00                      | 25         | 00   | 03   | 00  | PWD0 | 01  | PWD1 | ... | 00  | 29      | 8       |
| EXIT PASSWORD PROTECTION (90h/00h)                | X                       | 90         | X    | 00   |     |      |     |      |     |     | 3       |         |
| NONVOLATILE PROTECTION Commands                   |                         |            |      |      |     |      |     |      |     |     |         |         |
| ENTER NONVOLATILE PROTECTION<br>COMMAND SET (C0h) | 555                     | AA         | 2AA  | 55   | 555 | C0   |     |      |     |     |         | 3       |
| PROGRAM NONVOLATILE PROTECTION BIT (A0h)          | X                       | A0         | BAd  | 00   |     |      |     |      |     |     | 9       |         |
| READ NONVOLATILE PROTECTION BIT STATUS            | BAd                     | READ (DQ0) |      |      |     |      |     |      |     |     | 4, 6, 9 |         |
| CLEAR ALL NONVOLATILE PROTECTION BITS (80h/30h)   | X                       | 80         | 00   | 30   |     |      |     |      |     |     | 10      |         |
| EXIT NONVOLATILE PROTECTION (90h/00h)             | X                       | 90         | X    | 00   |     |      |     |      |     |     | 3       |         |
| NONVOLATILE PROTECTION BIT LOCK BIT Commands      |                         |            |      |      |     |      |     |      |     |     |         |         |

**Table 17: Block Protection Command Definitions – Address-Data Cycles (Continued)**

Notes 1 and 2 apply to entire table

Notes 1 and 2 apply to entire table

| Command and Code/Subcode                                    | Address and Data Cycles |            |     |    |     |    |              |      |     |     |         | Notes |
|-------------------------------------------------------------|-------------------------|------------|-----|----|-----|----|--------------|------|-----|-----|---------|-------|
|                                                             | 1st                     |            | 2nd |    | 3rd |    | 4th          |      | ... | nth |         |       |
|                                                             | A                       | D          | A   | D  | A   | D  | A            | D    |     | A   | D       |       |
| ENTER NONVOLATILE PROTECTION BIT LOCK BIT COMMAND SET (50h) | 555                     | AA         | 2AA | 55 | 555 | 50 |              |      |     |     |         | 3     |
| PROGRAM NONVOLATILE PROTECTION BIT LOCK BIT (A0h)           | X                       | A0         | X   | 00 |     |    |              |      |     |     | 9       |       |
| READ NONVOLATILE PROTECTION BIT LOCK BIT STATUS             | X                       | READ (DQ0) |     |    |     |    |              |      |     |     | 4, 6, 9 |       |
| EXIT NONVOLATILE PROTECTION BIT LOCK BIT (90h/00h)          | X                       | 90         | X   | 00 |     |    |              |      |     |     | 3       |       |
| VOLATILE PROTECTION Commands                                |                         |            |     |    |     |    |              |      |     |     |         |       |
| ENTER VOLATILE PROTECTION COMMAND SET (E0h)                 | 555                     | AA         | 2AA | 55 | 555 | E0 |              |      |     |     |         | 3     |
| PROGRAM VOLATILE PROTECTION BIT (A0h)                       | X                       | A0         | BAd | 00 |     |    |              |      |     |     | 9       |       |
| READ VOLATILE PROTECTION BIT STATUS                         | BAd                     | READ (DQ0) |     |    |     |    |              |      |     |     | 4, 6    |       |
| CLEAR VOLATILE PROTECTION BIT (A0h)                         | X                       | A0         | BAd | 01 |     |    |              |      |     |     | 9       |       |
| EXIT VOLATILE PROTECTION (90h/00h)                          | X                       | 90         | X   | 00 |     |    |              |      |     |     | 3       |       |
| EXTENDED MEMORY BLOCK Operations                            |                         |            |     |    |     |    |              |      |     |     |         |       |
| ENTER EXTENDED MEMORY BLOCK (88h)                           | 555                     | AA         | 2AA | 55 | 555 | 88 |              |      |     |     |         |       |
| PROGRAM EXTENDED MEMORY BLOCK (A0h)                         | 555                     | AA         | 2AA | 55 | 555 | A0 | Word address | data |     |     |         |       |
| READ EXTENDED MEMORY BLOCK                                  | Word address            | data       |     |    |     |    |              |      |     |     |         |       |
| EXIT EXTENDED MEMORY BLOCK (90h/00h)                        | 555                     | AA         | 2AA | 55 | 555 | 90 | X            | 00   |     |     |         |       |

Notes: 1. Key: A = Address and D = Data; X = "Don't Care;" BAd = Any address in the block; PWDn = Password words, n = 0 to 3; PWDn = Password address, n = 0 to 3; Gray = Not applicable. All values in the table are hexadecimal.

2. DQ[15:8] are "Don't Care" during UNLOCK and COMMAND cycles. A[MAX:16] are "Don't Care" during UNLOCK and COMMAND cycles, unless an address is required.
3. The ENTER command sequence must be issued prior to any operation. It disables READ and WRITE operations from and to block 0. READ and WRITE operations from and to any other block are allowed. Also, when an ENTER COMMAND SET command is issued, an EXIT COMMAND SET command must be issued to return the device to READ mode.
4. READ REGISTER/PASSWORD commands have no command code; CE# and OE# are driven LOW and data is read according to a specified address.
5. Data = Lock register content.
6. All address cycles shown for this command are READ cycles.
7. Only one portion of the password can be programmed or read by each PROGRAM PASSWORD command.
8. Each portion of the password can be entered or read in any order as long as the entire 64-bit password is entered or read.
9. Both nonvolatile and volatile protection bit settings are as follows: Protected state = 00; Unprotected state = 01.
10. The CLEAR ALL NONVOLATILE PROTECTION BITS command programs all nonvolatile protection bits before erasure. This prevents over-erasure of previously cleared nonvolatile protection bits.

## Protection Operations

Blocks can be protected individually against accidental PROGRAM or ERASE operations. The block protection scheme is shown in the Software Protection Scheme figure. Memory block and extended memory block protection is configured through the lock register.

### LOCK REGISTER Commands

After the ENTER LOCK REGISTER COMMAND SET (40h) command has been issued, all bus READ or PROGRAM operations can be issued to the lock register.

The PROGRAM LOCK REGISTER (A0h) command allows the lock register to be configured. The programmed data can then be checked with a READ LOCK REGISTER command by driving CE# and OE# LOW with the appropriate address data on the address bus.

### PASSWORD PROTECTION Commands

After the ENTER PASSWORD PROTECTION COMMAND SET (60h) command has been issued, the commands related to password protection mode can be issued to the device.

The PROGRAM PASSWORD (A0h) command is used to program the 64-bit password used in the password protection mode. To program the 64-bit password, the complete command sequence must be entered four times at four consecutive addresses selected by A[1:0]. By default, all password bits are set to 1. The password can be checked by issuing a READ PASSWORD command.

**Note:** A password must be programmed per Flash memory die to enable password protection.

The READ PASSWORD command is used to verify the password used in password protection mode. To verify the 64-bit password, the complete command sequence must be entered four times at four consecutive addresses selected by A[1:0]. If the password mode lock bit is programmed and the user attempts to read the password, the device will output 00h onto the I/O data bus.

The UNLOCK PASSWORD (25/03h) command is used to clear the nonvolatile protection bit lock bit, allowing the nonvolatile protection bits to be modified. The UNLOCK PASSWORD command must be issued, along with the correct password, and requires a 6μs delay between successive UNLOCK PASSWORD commands in order to prevent hackers from cracking the password by trying all possible 64-bit combinations. If this delay does not occur, the latest command will be ignored. Approximately 6μs is required for unlocking the device after the valid 64-bit password has been provided.

### NONVOLATILE PROTECTION Commands

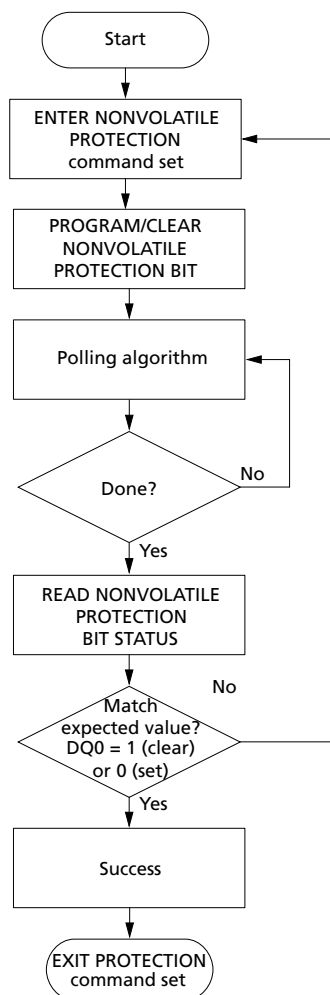
After the ENTER NONVOLATILE PROTECTION COMMAND SET (C0h) command has been issued, the commands related to nonvolatile protection mode can be issued to the device.

A block can be protected from program or erase by issuing a PROGRAM NONVOLATILE PROTECTION BIT (A0h) command, along with the block address. This command sets the nonvolatile protection bit to 0 for a given block.

The status of a nonvolatile protection bit for a given block or group of blocks can be read by issuing a READ NONVOLATILE MODIFY PROTECTION BIT command, along with the block address.

The nonvolatile protection bits are erased simultaneously by issuing a CLEAR ALL NONVOLATILE PROTECTION BITS (80/30h) command. No specific block address is required. If the nonvolatile protection bit lock bit is set to 0, the command fails.

**Figure 12: Set/Clear Nonvolatile Protection Bit Algorithm Flowchart**



- Notes:
1. See the Block Protection Command Definitions table for address-data cycle details.
  2. DQ5 and DQ1 are ignored in this algorithm flow.

## NONVOLATILE PROTECTION BIT LOCK BIT Commands

After the ENTER NONVOLATILE PROTECTION BIT LOCK BIT COMMAND SET (50h) command has been issued, the commands that allow the nonvolatile protection bit lock bit to be set can be issued to the device.

The PROGRAM NONVOLATILE PROTECTION BIT LOCK BIT (A0h) command is used to set the nonvolatile protection bit lock bit to 0, thus locking the nonvolatile protection bits and preventing them from being modified.

The READ NONVOLATILE PROTECTION BIT LOCK BIT STATUS command is used to read the status of the nonvolatile protection bit lock bit.

## VOLATILE PROTECTION Commands

After the ENTER VOLATILE PROTECTION COMMAND SET (E0h) command has been issued, commands related to the volatile protection mode can be issued to the device.

The PROGRAM VOLATILE PROTECTION BIT (A0h) command individually sets a volatile protection bit to 0 for a given block. If the nonvolatile protection bit for the same block is set, the block is locked regardless of the value of the volatile protection bit (see the Block Protection Status table).

The status of a volatile protection bit for a given block can be read by issuing a READ VOLATILE PROTECTION BIT STATUS command along with the block address.

The CLEAR VOLATILE PROTECTION BIT (A0h) command individually clears (sets to 1) the volatile protection bit for a given block. If the nonvolatile protection bit for the same block is set, the block is locked regardless of the value of the volatile protection bit (see the Block Protection Status table).

## EXTENDED MEMORY BLOCK Commands

The device has one extra 512-word extended memory block that can be accessed only by the ENTER EXTENDED MEMORY BLOCK (88h) command. It is used as a security block to provide a permanent 128-bit secure ID number or to store additional information. The device can be shipped with the extended memory block prelocked permanently by Micron, including the 128-bit security identification number. Or, the device can be shipped with the extended memory block unlocked, enabling customers to permanently program and lock it (default) (see Lock Register, the AUTO SELECT command, and the Block Protection table.)

**Table 18: Extended Memory Block Address and Data**

| Address         | Data                      |                                  |
|-----------------|---------------------------|----------------------------------|
|                 | Micron Prelocked          | Customer Lockable                |
| 000000h–000007h | Secure ID number          | Determined by customer (default) |
| 000008h–0001FFh | Protected and unavailable |                                  |

After the ENTER EXTENDED MEMORY BLOCK command has been issued, the device enters the extended memory block mode. All bus READ or PROGRAM operations are conducted on the extended memory block, and the extended memory block is addressed using the addresses occupied by block 0 in the other operating modes (see the Memory Map table).

In extended memory block mode, ERASE, CHIP ERASE, ERASE SUSPEND, and ERASE RESUME commands are not allowed. The extended memory block cannot be erased, and each bit of the extended memory block can only be programmed once.

The extended memory block is protected from further modification by programming lock register bit 0. Once invoked, this protection cannot be undone.

The device remains in extended memory block mode until the EXIT EXTENDED MEMORY BLOCK (90/00h) command is issued, which returns the device to read mode, or until power is removed from the device. After a power-up sequence or hardware reset, the device will revert to reading memory blocks in the main array.

## **EXIT PROTECTION Command**

The EXIT PROTECTION COMMAND SET (90/00h) command is used to exit the lock register, password protection, nonvolatile protection, volatile protection, and nonvolatile protection bit lock bit command set modes and return the device to read mode.

Note that the READ/RESET command (F0h) is ignored under these modes.

## Common Flash Interface

The common flash interface (CFI) is a JEDEC-approved, standardized data structure that can be read from the flash memory device. It allows a system's software to query the device to determine various electrical and timing parameters, density information, and functions supported by the memory. The system can interface easily with the device, enabling the software to upgrade itself when necessary.

When the READ CFI command is issued, the device enters CFI query mode and the data structure is read from memory. The following tables show the addresses (A[7:0]) used to retrieve the data. The query data is always presented on the lowest order data outputs (DQ[7:0]), and the other data outputs (DQ[15:8]) are set to 0.

**Table 19: Query Structure Overview**

Note 1 applies to the entire table

| Address | Subsection Name                                 | Description                                                         |
|---------|-------------------------------------------------|---------------------------------------------------------------------|
| 10h     | CFI query identification string                 | Command set ID and algorithm data offset                            |
| 1Bh     | System interface information                    | Device timing and voltage information                               |
| 27h     | Device geometry definition                      | Flash device layout                                                 |
| 40h     | Primary algorithm-specific extended query table | Additional information specific to the primary algorithm (optional) |

Note: 1. Query data are always presented on the lowest order data outputs (DQ[7:0]). DQ[15:8] are set to 0.

**Table 20: CFI Query Identification String**

Note 1 applies to the entire table

| Address    | Data           | Description                                                                                                  | Value   |
|------------|----------------|--------------------------------------------------------------------------------------------------------------|---------|
| 10h        | 0051h          | Query unique ASCII string "QRY"                                                                              | "Q"     |
| 11h        | 0052h          |                                                                                                              | "R"     |
| 12h        | 0059h          |                                                                                                              | "Y"     |
| 13h<br>14h | 0002h<br>0000h | Primary algorithm command set and control interface ID code 16-bit ID code defining a specific algorithm     | –       |
| 15h<br>16h | 0040h<br>0000h | Address for primary algorithm extended query table (see the Primary Algorithm-Specific Extended Query Table) | P = 40h |
| 17h<br>18h | 0000h<br>0000h | Alternate vendor command set and control interface ID code second vendor-specified algorithm supported       | –       |
| 19h<br>1Ah | 0000h<br>0000h | Address for alternate algorithm extended query table                                                         | –       |

Note: 1. Query data are always presented on the lowest order data outputs (DQ[7:0]). DQ[15:8] are set to 0.

**Table 21: CFI Query System Interface Information**

Note 1 applies to the entire table

| Address | Data  | Description                                                                                                                        | Value  |
|---------|-------|------------------------------------------------------------------------------------------------------------------------------------|--------|
| 1Bh     | 0027h | V <sub>CC</sub> logic supply minimum program/erase voltage<br>Bits[7:4] BCD value in volts<br>Bits[3:0] BCD value in 100mV         | 2.7V   |
| 1Ch     | 0036h | V <sub>CC</sub> logic supply maximum program/erase voltage<br>Bits[7:4] BCD value in volts<br>Bits[3:0] BCD value in 100mV         | 3.6V   |
| 1Dh     | 0085h | V <sub>HH</sub> (programming) supply minimum program/erase voltage<br>Bits[7:4] hex value in volts<br>Bits[3:0] BCD value in 100mV | 8.5V   |
| 1Eh     | 0095h | V <sub>HH</sub> (programming) supply maximum program/erase voltage<br>Bits[7:4] hex value in volts<br>Bits[3:0] BCD value in 10mV  | 9.5V   |
| 1Fh     | 0005h | Typical timeout for single byte/word program = 2 <sup>n</sup> μs                                                                   | 32μs   |
| 20h     | 0009h | Typical timeout for maximum size buffer program = 2 <sup>n</sup> μs                                                                | 512μs  |
| 21h     | 0008h | Typical timeout per individual block erase = 2 <sup>n</sup> ms                                                                     | 256ms  |
| 22h     | 0012h | Typical timeout for full chip erase = 2 <sup>n</sup> ms                                                                            | 262s   |
| 23h     | 0003h | Maximum timeout for byte/word program = 2 <sup>n</sup> times typical                                                               | 256μs  |
| 24h     | 0002h | Maximum timeout for buffer program = 2 <sup>n</sup> times typical                                                                  | 2048μs |
| 25h     | 0003h | Maximum timeout per individual block erase = 2 <sup>n</sup> times typical                                                          | 2s     |
| 26h     | 0003h | Maximum timeout for chip erase = 2 <sup>n</sup> times typical                                                                      | 2096s  |

Note: 1. The values in this table are valid for all packages.

**Table 22: Device Geometry Definition**

| Address | Data  | Description                                                                                                            | Value               |
|---------|-------|------------------------------------------------------------------------------------------------------------------------|---------------------|
| 27h     | 001Bh | Device size = 2 <sup>n</sup> in number of bytes                                                                        | 128MB               |
| 28h     | 0001h | Flash device interface code description                                                                                | x16<br>asynchronous |
| 29h     | 0000h |                                                                                                                        |                     |
| 2Ah     | 000Ah | Maximum number of bytes in multi-byte program or page = 2 <sup>n</sup>                                                 | 1024                |
| 2Bh     | 0000h |                                                                                                                        |                     |
| 2Ch     | 0001h | Number of erase block regions. It specifies the number of regions containing contiguous erase blocks of the same size. | 1                   |
| 2Dh     | 00FFh | Erase block region 1 information                                                                                       | 1024                |
| 2Eh     | 0003h | Number of identical-size erase blocks = 01FFh + 1                                                                      |                     |
| 2Fh     | 0000h | Erase block region 1 information                                                                                       | 128KB               |
| 30h     | 0002h | Block size in region 1 = 0200h × 256 bytes                                                                             |                     |
| 31h     | 0000h | Erase block region 2 information                                                                                       | 0                   |
| 32h     | 0000h |                                                                                                                        |                     |
| 33h     | 0000h |                                                                                                                        |                     |
| 34h     | 0000h |                                                                                                                        |                     |

**Table 22: Device Geometry Definition (Continued)**

| Address                  | Data                             | Description                      | Value |
|--------------------------|----------------------------------|----------------------------------|-------|
| 35h<br>36h<br>37h<br>38h | 0000h<br>0000h<br>0000h<br>0000h | Erase block region 3 information | 0     |
| 39h<br>3Ah<br>3Bh<br>3Ch | 0000h<br>0000h<br>0000h<br>0000h | Erase block region 4 information | 0     |
| 3Dh<br>3Eh<br>3Fh        | FFFFh<br>FFFFh<br>FFFFh          | Reserved                         | –     |

**Table 23: Primary Algorithm-Specific Extended Query Table**

Note 1 applies to the entire table

| Address | Data  | Description                                                                                                                                | Value         |
|---------|-------|--------------------------------------------------------------------------------------------------------------------------------------------|---------------|
| 40h     | 0050h | Primary algorithm extended query table unique ASCII string "PRI"                                                                           | "P"           |
| 41h     | 0052h |                                                                                                                                            | "R"           |
| 42h     | 0049h |                                                                                                                                            | "I"           |
| 43h     | 0031h | Major version number, ASCII                                                                                                                | "1"           |
| 44h     | 0035h | Minor version number, ASCII                                                                                                                | "5"           |
| 45h     | 001Ch | Address sensitive unlock (bits[1:0]):<br>00 = Required<br>01 = Not required<br>Process technology (bits [7:2])<br>0111b: Second generation | Required      |
| 46h     | 0002h | Erase suspend:<br>00 = Not supported<br>01 = Read only<br>02 = Read and write                                                              | 2             |
| 47h     | 0001h | Block protection:<br>00 = Not supported<br>x = Number of blocks per group                                                                  | 1             |
| 48h     | 0000h | Temporary block unprotect scheme:<br>00 = Not supported<br>01 = Supported                                                                  | Not supported |
| 49h     | 0008h | Protect/unprotect scheme:<br>08 = Advanced sector protection method                                                                        | 8             |
| 4Ah     | 0000h | Simultaneous operations:<br>Not supported                                                                                                  | –             |
| 4Bh     | 0000h | Burst mode:<br>00 = Not supported<br>01 = Supported                                                                                        | Not supported |

**Table 23: Primary Algorithm-Specific Extended Query Table (Continued)**

Note 1 applies to the entire table

| Address | Data  | Description                                                                                                                              | Value                                                                   |
|---------|-------|------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------|
| 4Ch     | 0003h | Page mode:<br>00 = Not supported<br>01 = 4-word page<br>02 = 8-word page<br>03 = 16-word page                                            | 16-word page                                                            |
| 4Dh     | 0085h | V <sub>HH</sub> supply minimum program/erase voltage:<br>Bits[7:4] hex value in volts<br>Bits[3:0] BCD value in 100mV                    | 8.5V                                                                    |
| 4Eh     | 0095h | V <sub>HH</sub> supply maximum program/erase voltage:<br>Bits[7:4] hex value in volts<br>Bits[3:0] BCD value in 100mV                    | 9.5V                                                                    |
| 4Fh     | 00xxh | WP# protection:<br>xx = 04h: Uniform device, HW protection for lowest block<br>xx = 05h: Uniform device, HW protection for highest block | Uniform + V <sub>pp</sub> /WP#<br>protecting highest<br>or lowest block |
| 50h     | 0001h | Program suspend:<br>00 = Not supported<br>01 = Supported                                                                                 | Supported                                                               |
| 51h     | 0001h | Unlock bypass:<br>00 = Not supported<br>01 = Supported                                                                                   | Supported                                                               |
| 52h     | 000Ah | Extended memory block (customer OTP area): 2 <sup>n</sup> bytes                                                                          | 1024 bytes                                                              |

**Table 23: Primary Algorithm-Specific Extended Query Table (Continued)**

Note 1 applies to the entire table

| Address    | Data  | Description                                                                     | Value    |
|------------|-------|---------------------------------------------------------------------------------|----------|
| 53h        | 008Fh | Software Features                                                               | –        |
|            |       | bit 0: Status register polling<br>00 = Not supported<br>01 = Supported)         |          |
|            |       | bit 1: DQ polling<br>00 = Not supported<br>01 = Supported)                      |          |
|            |       | bit 2: Program suspend/resume commands<br>00 = Not supported<br>01 = Supported) |          |
|            |       | bit 3: Word programming<br>00 = Not supported<br>01 = Supported)                |          |
|            |       | bit 4: Bit-field programming<br>00 = Not supported<br>01 = Supported)           |          |
|            |       | bit 5: Autodetect programming<br>00 = Not supported<br>01 = Supported)          |          |
|            |       | bit 6: RFU                                                                      |          |
|            |       | bit 7: Multiple writes per line<br>00 = Not supported<br>01 = Supported)        |          |
| 54h        | 0005h | Page size: 2 <sup>n</sup> bytes                                                 | 32 bytes |
| 55h        | 0005h | Erase suspend timeout maximum: 2 <sup>n</sup> (μs)                              | 32μs     |
| 56h        | 0004h | Program suspend timeout maximum: 2 <sup>n</sup> (μs)                            | 16μs     |
| 57h to 77h | FFFFh | Reserved                                                                        | –        |
| 78h        | 0005h | <sup>t</sup> PLRH maximum: 2 <sup>n</sup> (μs)                                  | 32μs     |
| 79h        | 0009h | <sup>t</sup> VCCPH maximum: 2 <sup>n</sup> (μs)<br>Power-on reset               | 512μs    |

Note: 1. The values in this table are valid for both packages.

## Power-Up and Reset Characteristics

**Table 24: Power-Up Specifications**

Note 1 applies to entire table.

| Parameter                             | Symbol     |               | Min | Unit    | Notes |
|---------------------------------------|------------|---------------|-----|---------|-------|
|                                       | Legacy     | JEDEC         |     |         |       |
| $V_{CC}$ HIGH to $V_{CCQ}$ HIGH       | –          | $t_{VCHVCQH}$ | 0   | $\mu s$ | 2     |
| $V_{CC}$ HIGH to rising edge of RST#  | $t_{VCS}$  | $t_{VCHPH}$   | 300 | $\mu s$ | 3, 4  |
| $V_{CCQ}$ HIGH to rising edge of RST# | $t_{VIOS}$ | $t_{VCQHPH}$  | 0   | $\mu s$ | 3, 4  |
| RST# HIGH to chip enable LOW          | $t_{RH}$   | $t_{PHEL}$    | 50  | ns      |       |
| RST# HIGH to write enable LOW         | –          | $t_{PHWL}$    | 150 | ns      |       |

- Notes:
1. Sampled only; not 100% tested.
  2.  $V_{CC}$  should attain  $V_{CC,min}$  from  $V_{SS}$  simultaneously with or prior to applying  $V_{CCQ}$  during power up.  $V_{CC}$  should attain  $V_{SS}$  during power down.
  3. If RST# is not stable for  $t_{VCS}$  or  $t_{VIOS}$ , the device will not allow any READ or WRITE operations, and a hardware reset is required.
  4. Power supply transitions should only occur when RST# is LOW.

**Figure 13: Power-Up Timing**

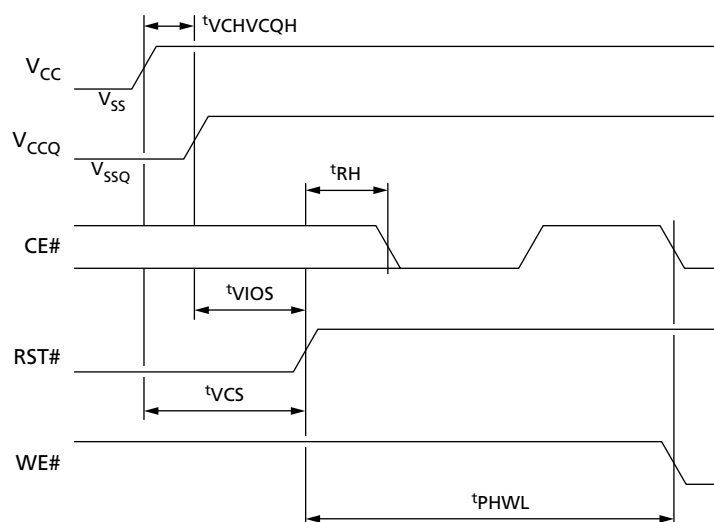
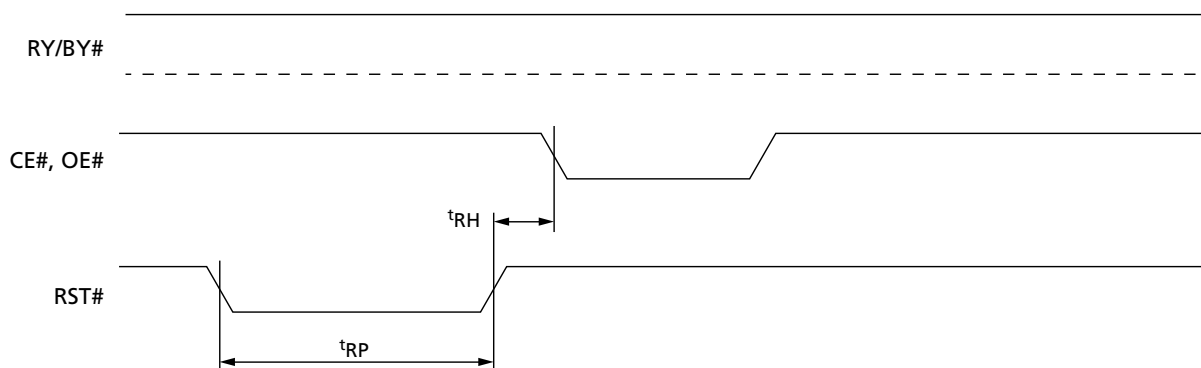
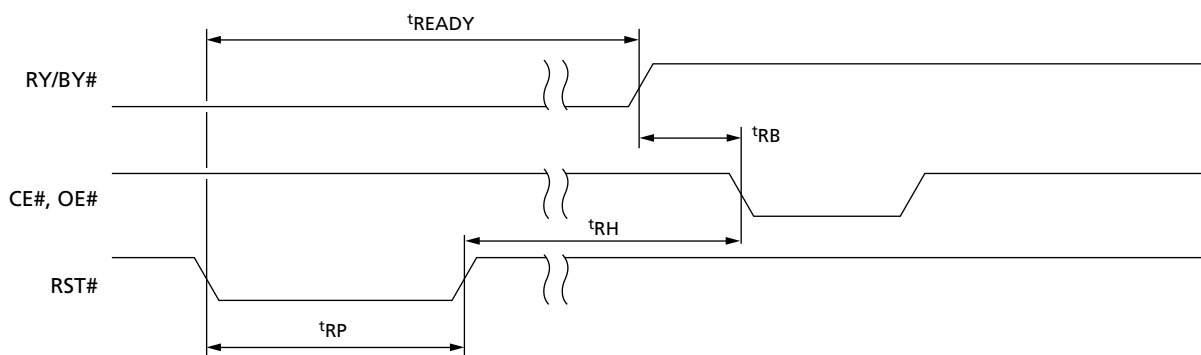


**Table 25: Reset AC Specifications**

| Condition/Parameter                              | Symbol             |                                    | Min | Max | Unit          | Notes |
|--------------------------------------------------|--------------------|------------------------------------|-----|-----|---------------|-------|
|                                                  | Legacy             | JEDEC                              |     |     |               |       |
| RST# LOW to read mode during program or erase    | $t_{\text{READY}}$ | $t_{\text{PLRH}}$                  | –   | 25  | $\mu\text{s}$ | 1     |
| RST# pulse width                                 | $t_{\text{RP}}$    | $t_{\text{PLPH}}$                  | 100 | –   | ns            |       |
| RST# HIGH to CE# LOW, OE# LOW                    | $t_{\text{RH}}$    | $t_{\text{PHEL}}, t_{\text{PHGL}}$ | 50  | –   | ns            | 1     |
| RST# LOW to standby mode during read mode        | $t_{\text{RPD}}$   | –                                  | 0   | –   | $\mu\text{s}$ |       |
| RST# LOW to standby mode during program or erase |                    |                                    | 0   | –   | $\mu\text{s}$ |       |
| RY/BY# HIGH to CE# LOW, OE# LOW                  | $t_{\text{RB}}$    | $t_{\text{RHEL}}, t_{\text{RHGL}}$ | 0   | –   | ns            | 1     |

Note: 1. Sampled only; not 100% tested.

**Figure 14: Reset AC Timing – No PROGRAM/ERASE Operation in Progress**

**Figure 15: Reset AC Timing During PROGRAM/ERASE Operation**


## Absolute Ratings and Operating Conditions

Stresses greater than those listed may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may adversely affect reliability.

**Table 26: Absolute Maximum/Minimum Ratings**

| Parameter                   | Symbol     | Min  | Max           | Unit | Notes |
|-----------------------------|------------|------|---------------|------|-------|
| Temperature under bias      | $T_{BIAS}$ | -50  | 125           | °C   |       |
| Storage temperature         | $T_{STG}$  | -65  | 150           | °C   |       |
| Supply voltage              | $V_{CC}$   | -0.6 | $V_{CC} + 2$  | V    | 1, 2  |
| Input/output supply voltage | $V_{CCQ}$  | -0.6 | $V_{CCQ} + 2$ | V    | 1, 2  |
| Program/erase voltage       | $V_{PP}$   | -0.6 | 9.5           | V    | 3     |

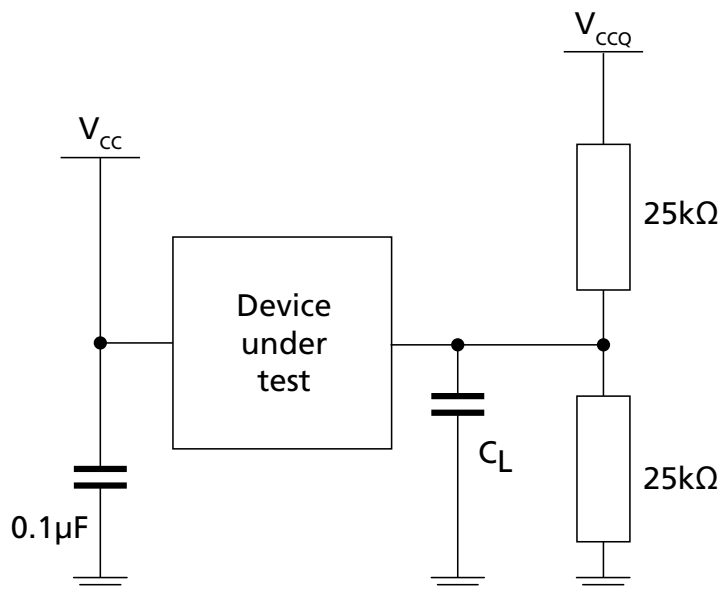
- Notes:
1. During signal transitions, minimum voltage may undershoot to -2V for periods less than 20ns.
  2. During signal transitions, maximum voltage may overshoot to  $V_{CC} + 2V$  for periods less than 20ns.
  3.  $V_{PP}$  must not remain at 9.5V for more than 80 hours cumulative.

**Table 27: Operating Conditions**

| Parameter                                             | Symbol    | Min            | Max | Unit | Notes |
|-------------------------------------------------------|-----------|----------------|-----|------|-------|
| Supply voltage                                        | $V_{CC}$  | 2.7            | 3.6 | V    |       |
| Input/output supply voltage ( $V_{CCQ} \leq V_{CC}$ ) | $V_{CCQ}$ | 1.65           | 3.6 | V    |       |
| Accelerated buffered program/chip erase voltage       | $V_{HH}$  | 8.5            | 9.5 | V    |       |
| Ambient operating temperature                         | $T_A$     | -40            | 105 | °C   |       |
| Load capacitance                                      | $C_L$     | 30             |     | pF   |       |
| Input rise and fall times ( $V_{IL}$ to $V_{IH}$ )    | —         | 0.3            | 2.5 | ns   | 1, 2  |
| Input pulse voltages                                  | —         | 0 to $V_{CCQ}$ |     | V    |       |
| Input and output timing reference voltages            | —         | $V_{CCQ}/2$    |     | V    |       |
| Address to address skew                               | —         | —              | 3   | ns   |       |

- Notes:
1. If the rise/fall time is slower than 2.5ns, all timing specs must be derated by 0.5ns for every nanosecond push-out in rise/fall time. (Example: for a 10ns rise/fall time, all timing specs must be derated by  $(10 - 2.5) \times (0.5ns) = 3.75ns$ .)
  2. Applies to Address, CE#, OE#, and WE# signals.

**Figure 16: AC Measurement Load Circuit**



Note: 1.  $C_L$  includes jig capacitance.

**Figure 17: AC Measurement I/O Waveform**

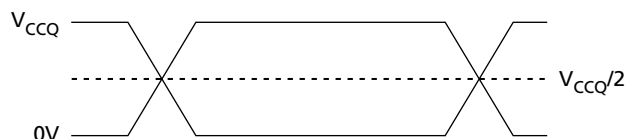


**Table 28: Input/Output Capacitance**

| Parameter          | Symbol    | Test Condition | Min | Max | Unit |
|--------------------|-----------|----------------|-----|-----|------|
| Input capacitance  | $C_{IN}$  | $V_{IN} = 0V$  | 3   | 11  | pF   |
| Output capacitance | $C_{OUT}$ | $V_{OUT} = 0V$ | 3   | 7   | pF   |

## DC Characteristics

**Table 29: DC Current Characteristics**

| Parameter                                            |                           | Symbol              | Conditions                                                                                                                                                                                              |                                                           | Min  | Typ  | Max | Unit | Notes |
|------------------------------------------------------|---------------------------|---------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------|------|------|-----|------|-------|
| Input load current                                   |                           | I <sub>LI</sub>     | 0V ≤ V <sub>IN</sub> ≤ V <sub>CC</sub>                                                                                                                                                                  |                                                           | –    | –    | ±1  | μA   | 1     |
| Output leakage current                               |                           | I <sub>LO</sub>     | 0V ≤ V <sub>OUT</sub> ≤ V <sub>CC</sub>                                                                                                                                                                 |                                                           | –    | –    | ±1  | μA   |       |
| V <sub>CC</sub> read current                         | Random read               | I <sub>CC1</sub>    | CE# = V <sub>IL</sub> , OE# = V <sub>IH</sub> ,<br>f = 5 MHz                                                                                                                                            |                                                           | –    | 26   | 31  | mA   |       |
|                                                      | Page read                 |                     | CE# = V <sub>IL</sub> , OE# = V <sub>IH</sub> ,<br>f = 13 MHz                                                                                                                                           |                                                           | –    | 12   | 16  | mA   |       |
| V <sub>CC</sub> standby current                      |                           | I <sub>CC2</sub>    | CE# = V <sub>CCQ</sub> ±0.2V,<br>RST# = V <sub>CCQ</sub> ±0.2V                                                                                                                                          |                                                           | –    | 75   | 230 | μA   |       |
| V <sub>CC</sub> automatic power saving (APS) current |                           | I <sub>CC APS</sub> | V <sub>CC</sub> = V <sub>CC,max</sub> ,<br>V <sub>CCQ</sub> = V <sub>CCQ,max</sub><br>CE# = V <sub>SSQ</sub> ,<br>RST# = V <sub>CCQ</sub> ,<br>All inputs are at V <sub>CCQ</sub><br>or V <sub>SS</sub> |                                                           | –    | –    | 2   | mA   |       |
| V <sub>CC</sub> program/erase/blank check current    |                           | I <sub>CC3</sub>    | Program/erase controller active                                                                                                                                                                         | V <sub>pp</sub> /WP# = V <sub>IL</sub> or V <sub>IH</sub> | –    | 35   | 50  | mA   | 2     |
|                                                      |                           |                     |                                                                                                                                                                                                         | V <sub>pp</sub> /WP# = V <sub>HH</sub>                    | –    | 35   | 50  | mA   |       |
| V <sub>pp</sub> current                              | Read                      | I <sub>pp1</sub>    | V <sub>pp</sub> /WP# ≤ V <sub>CC</sub>                                                                                                                                                                  |                                                           | –    | 2    | 15  | μA   |       |
|                                                      | Standby                   | I <sub>pp2</sub>    |                                                                                                                                                                                                         |                                                           | –    | 0.2  | 5   | μA   |       |
|                                                      | PROGRAM operation ongoing | I <sub>pp3</sub>    | V <sub>pp</sub> /WP# = V <sub>HH</sub>                                                                                                                                                                  | –                                                         | 5    | 10   | mA  |      |       |
|                                                      |                           |                     | V <sub>pp</sub> /WP# = V <sub>CC</sub>                                                                                                                                                                  | –                                                         | 0.05 | 0.10 | mA  |      |       |
|                                                      | ERASE operation ongoing   | I <sub>pp4</sub>    | V <sub>pp</sub> /WP# = V <sub>HH</sub>                                                                                                                                                                  | –                                                         | 5    | 10   | mA  |      |       |
|                                                      |                           |                     | V <sub>pp</sub> /WP# = V <sub>CC</sub>                                                                                                                                                                  | –                                                         | 0.05 | 0.10 | mA  |      |       |

- Notes: 1. The maximum input load current is  $\pm 5\mu A$  on the  $V_{pp}/WP\#$  pin.  
2. Sampled only; not 100% tested.

**Table 30: DC Voltage Characteristics**

| Parameter                                      | Symbol    | Conditions                                                                  | Min           | Typ | Max             | Unit | Notes |
|------------------------------------------------|-----------|-----------------------------------------------------------------------------|---------------|-----|-----------------|------|-------|
| Input LOW voltage                              | $V_{IL}$  | $V_{CC} \geq 2.7V$                                                          | -0.5          | –   | 0.8             | V    |       |
| Input HIGH voltage                             | $V_{IH}$  | $V_{CC} \geq 2.7V$                                                          | $0.7V_{CCQ}$  | –   | $V_{CCQ} + 0.4$ | V    |       |
| Output LOW voltage                             | $V_{OL}$  | $I_{OL} = 100\mu A$ ,<br>$V_{CC} = V_{CC,min}$ ,<br>$V_{CCQ} = V_{CCQ,min}$ | –             | –   | $0.15V_{CCQ}$   | V    |       |
| Output HIGH voltage                            | $V_{OH}$  | $I_{OH} = 100\mu A$ ,<br>$V_{CC} = V_{CC,min}$ ,<br>$V_{CCQ} = V_{CCQ,min}$ | $0.85V_{CCQ}$ | –   | –               | V    |       |
| Voltage for $V_{PP}/WP\#$ program acceleration | $V_{PP}$  | –                                                                           | 8.5           | –   | 9.5             | V    | 1     |
| Program/erase lockout supply voltage           | $V_{LKO}$ | –                                                                           | 2.0           | –   | –               | V    | 2, 3  |

- Notes:
1.  $V_{PP}$  must not remain at 9.5V for more than 80 hours cumulative.
  2. Sampled only; not 100% tested.
  3. WRITE operations are not valid when  $V_{CC}$  supply drops below  $V_{LKO}$ .

## Read AC Characteristics

**Table 31: Read AC Characteristics –  $V_{CC} = V_{CCQ} = 2.7\text{--}3.6\text{V}$** 

| Parameter                                                      | Symbol     |                                            | Condition                            | Min | Max | Unit | Notes |
|----------------------------------------------------------------|------------|--------------------------------------------|--------------------------------------|-----|-----|------|-------|
|                                                                | Legacy     | JEDEC                                      |                                      |     |     |      |       |
| Address valid to next address valid                            | $t_{RC}$   | $t_{AVAV}$                                 | $CE\# = V_{IL}$ ,<br>$OE\# = V_{IL}$ | 105 | –   | ns   |       |
| Address valid to output valid                                  | $t_{ACC}$  | $t_{AVQV}$                                 | $CE\# = V_{IL}$ ,<br>$OE\# = V_{IL}$ | –   | 105 | ns   |       |
| Address valid to output valid (page)                           | $t_{PAGE}$ | $t_{AVQV1}$                                | $CE\# = V_{IL}$ ,<br>$OE\# = V_{IL}$ | –   | 20  | ns   |       |
| CE# LOW to output valid                                        | $t_{CE}$   | $t_{ELQV}$                                 | $OE\# = V_{IL}$                      | –   | 105 | ns   |       |
| OE# LOW to output valid                                        | $t_{OE}$   | $t_{GLQV}$                                 | $CE\# = V_{IL}$                      | –   | 25  | ns   |       |
| CE# HIGH to output High-Z                                      | $t_{HZ}$   | $t_{EHQZ}$                                 | $OE\# = V_{IL}$                      | –   | 20  | ns   | 1     |
| OE# HIGH to output High-Z                                      | $t_{DF}$   | $t_{GHQZ}$                                 | $CE\# = V_{IL}$                      | –   | 15  | ns   | 1     |
| CE# HIGH, OE# HIGH, or address transition to output transition | $t_{OH}$   | $t_{EHQX}$ ,<br>$t_{GHQX}$ ,<br>$t_{AXQX}$ | –                                    | 0   | –   | ns   |       |

Note: 1. Sampled only; not 100% tested.

**Table 32: Read AC Characteristics –  $V_{CCQ} = 1.65\text{V--}V_{CC}$** 

| Parameter                                                      | Symbol     |                                            | Condition                            | Min | Max | Unit | Notes |
|----------------------------------------------------------------|------------|--------------------------------------------|--------------------------------------|-----|-----|------|-------|
|                                                                | Legacy     | JEDEC                                      |                                      |     |     |      |       |
| Address valid to next address valid                            | $t_{RC}$   | $t_{AVAV}$                                 | $CE\# = V_{IL}$ ,<br>$OE\# = V_{IL}$ | 110 | –   | ns   |       |
| Address valid to output valid                                  | $t_{ACC}$  | $t_{AVQV}$                                 | $CE\# = V_{IL}$ ,<br>$OE\# = V_{IL}$ | –   | 110 | ns   |       |
| Address valid to output valid (page)                           | $t_{PAGE}$ | $t_{AVQV1}$                                | $CE\# = V_{IL}$ ,<br>$OE\# = V_{IL}$ | –   | 25  | ns   |       |
| CE# LOW to output valid                                        | $t_{CE}$   | $t_{ELQV}$                                 | $OE\# = V_{IL}$                      | –   | 110 | ns   |       |
| OE# LOW to output valid                                        | $t_{OE}$   | $t_{GLQV}$                                 | $CE\# = V_{IL}$                      | –   | 25  | ns   |       |
| CE# HIGH to output High-Z                                      | $t_{HZ}$   | $t_{EHQZ}$                                 | $OE\# = V_{IL}$                      | –   | 20  | ns   | 1     |
| OE# HIGH to output High-Z                                      | $t_{DF}$   | $t_{GHQZ}$                                 | $CE\# = V_{IL}$                      | –   | 15  | ns   | 1     |
| CE# HIGH, OE# HIGH, or address transition to output transition | $t_{OH}$   | $t_{EHQX}$ ,<br>$t_{GHQX}$ ,<br>$t_{AXQX}$ | –                                    | 0   | –   | ns   |       |

Note: 1. Sampled only; not 100% tested.

**Figure 18: Random Read AC Timing**

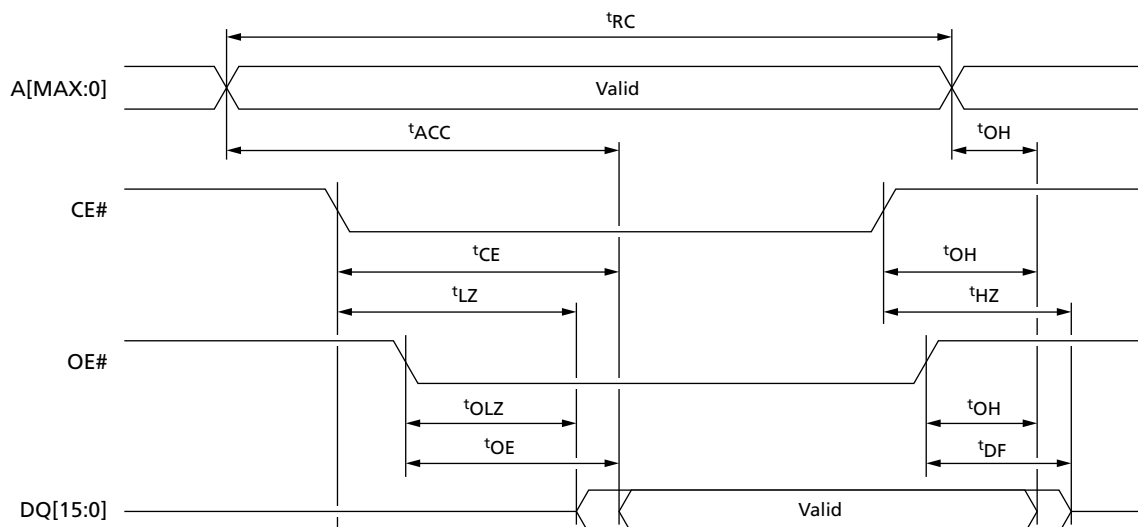
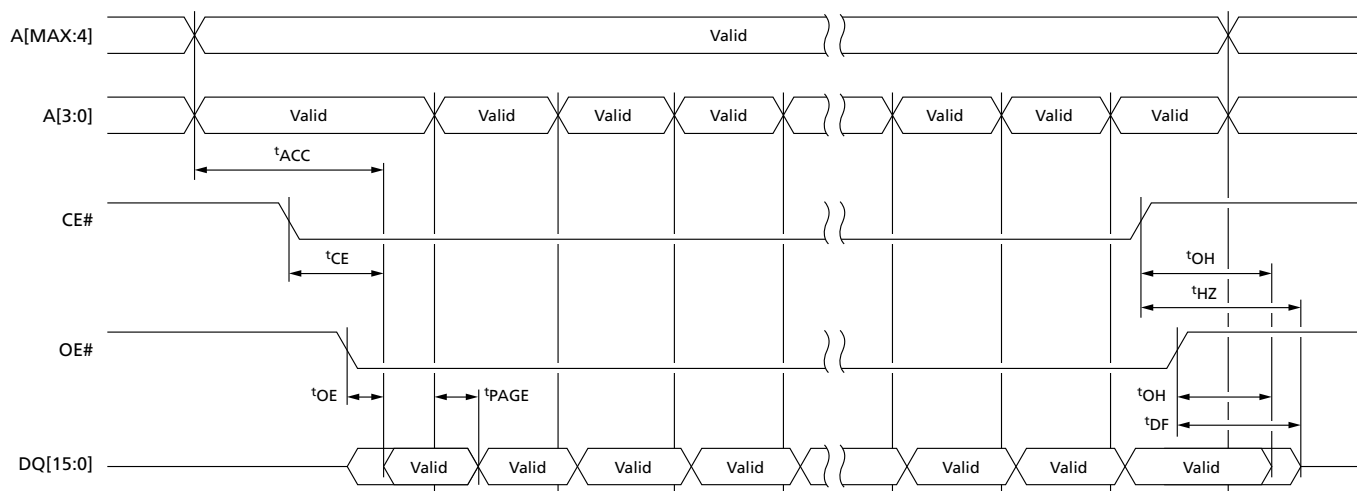


**Figure 19: Page Read AC Timing**



Note: 1. Page size is 16 words and is addressed by address inputs A[3:0].

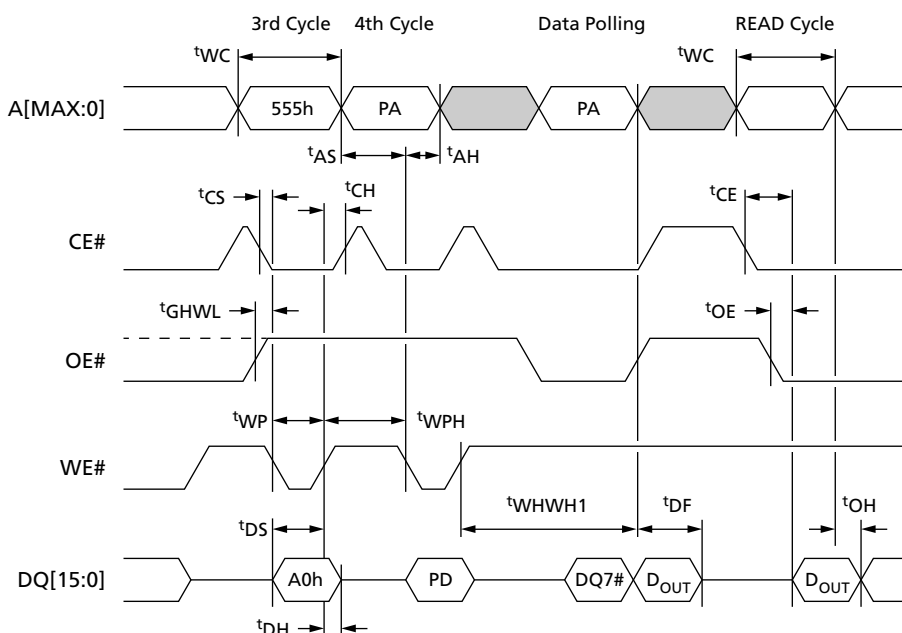
## Write AC Characteristics

**Table 33: WE#-Controlled Write AC Characteristics**

| Parameter                                   | Symbol     |             | Min             | Typ | Max | Unit | Notes |
|---------------------------------------------|------------|-------------|-----------------|-----|-----|------|-------|
|                                             | Legacy     | JEDEC       |                 |     |     |      |       |
| WRITE cycle time                            | $t_{WC}$   | –           | 60              | –   | –   | ns   |       |
| CE# LOW to WE# LOW                          | $t_{CS}$   | $t_{ELWL}$  | 0               | –   | –   | ns   |       |
| WE# LOW to WE# HIGH                         | $t_{WP}$   | $t_{WLWH}$  | 35              | –   | –   | ns   |       |
| Input valid to WE# HIGH                     | $t_{DS}$   | $t_{DVWH}$  | 30              | –   | –   | ns   | 1     |
| WE# HIGH to input transition                | $t_{DH}$   | $t_{WHDX}$  | 0               | –   | –   | ns   |       |
| WE# HIGH to CE# HIGH                        | $t_{CH}$   | $t_{WHEH}$  | 0               | –   | –   | ns   |       |
| WE# HIGH to WE# LOW                         | $t_{WPH}$  | $t_{WHWL}$  | 20              | –   | –   | ns   |       |
| Address valid to WE# LOW                    | $t_{AS}$   | $t_{AVWL}$  | 0               | –   | –   | ns   |       |
| WE# LOW to address transition               | $t_{AH}$   | $t_{WLAX}$  | 45              | –   | –   | ns   |       |
| OE# HIGH to WE# LOW                         | –          | $t_{GHWL}$  | 0               | –   | –   | ns   |       |
| WE# HIGH to OE# LOW                         | $t_{OEHL}$ | $t_{WHGL}$  | 0               | –   | –   | ns   |       |
| Program/erase valid to RY/BY# LOW           | $t_{BUSY}$ | $t_{WHRL}$  | –               | –   | 90  | ns   | 2     |
| WE# HIGH to OE# valid                       | –          | $t_{WHQV}$  | $t_{AVQV} + 30$ | –   | –   | ns   |       |
| $V_{HH}$ rise or fall time on $V_{pp}/WP\#$ | –          | $t_{VHVPP}$ | 250             | –   | –   | ns   |       |

- Notes:
1. The user's write timing must comply with this specification. Any violation of this write timing specification may result in permanent damage to the NOR Flash device.
  2. Sampled only; not 100% tested.

**Figure 20: WE#-Controlled Program AC Timing**



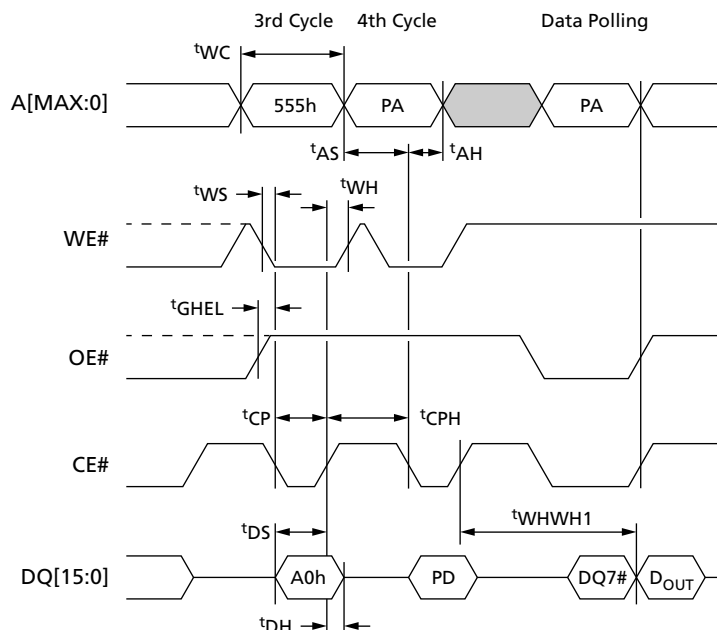
- Notes:
1. Only the third and fourth cycles of the PROGRAM command are represented. The PROGRAM command is followed by checking of the status register data polling bit and by a READ operation that outputs the data (D<sub>OUT</sub>) programmed by the previous PROGRAM command.
  2. PA is the address of the memory location to be programmed. PD is the data to be programmed.
  3. DQ7 is the complement of the data bit being programmed to DQ7 (See Data Polling Bit [DQ7]).
  4. See the following tables for timing details: Read AC Characteristics, WE#-Controlled Write AC Characteristics, and CE#-Controlled Write AC Characteristics.
  5. For t<sub>WVH1</sub> timing details, see the Program/Erase Characteristics table.

**Table 34: CE#-Controlled Write AC Characteristics**

| Parameter                                   | Symbol     |             | Min             | Typ | Max | Unit | Notes |
|---------------------------------------------|------------|-------------|-----------------|-----|-----|------|-------|
|                                             | Legacy     | JEDEC       |                 |     |     |      |       |
| WRITE cycle time                            | $t_{WC}$   | –           | 60              | –   | –   | ns   |       |
| WE# LOW to CE# LOW                          | $t_{WS}$   | $t_{WLEL}$  | 0               | –   | –   | ns   |       |
| CE# LOW to CE# HIGH                         | $t_{CP}$   | $t_{ELEH}$  | 35              | –   | –   | ns   |       |
| Input valid to CE# HIGH                     | $t_{DS}$   | $t_{DVEH}$  | 30              | –   | –   | ns   | 1     |
| CE# HIGH to input transition                | $t_{DH}$   | $t_{EHDX}$  | 0               | –   | –   | ns   |       |
| CE# HIGH to WE# HIGH                        | $t_{WH}$   | $t_{EHWH}$  | 0               | –   | –   | ns   |       |
| CE# HIGH to CE# LOW                         | $t_{CPH}$  | $t_{EHEL}$  | 20              | –   | –   | ns   |       |
| Address valid to CE# LOW                    | $t_{AS}$   | $t_{AVEL}$  | 0               | –   | –   | ns   |       |
| CE# LOW to address transition               | $t_{AH}$   | $t_{ELAX}$  | 45              | –   | –   | ns   |       |
| OE# HIGH to CE# LOW                         | –          | $t_{GHEL}$  | 0               | –   | –   | ns   |       |
| $V_{HH}$ rise or fall time on $V_{pp}/WP\#$ | –          | $t_{VHVPP}$ | 250             | –   | –   | ns   |       |
| Program/erase valid to RY/BY# LOW           | $t_{BUSY}$ | $t_{WHRL}$  | –               | –   | 90  | ns   | 2     |
| WE# HIGH to OE# valid                       | –          | $t_{WHQV}$  | $t_{AVQV} + 30$ | –   | –   | ns   |       |

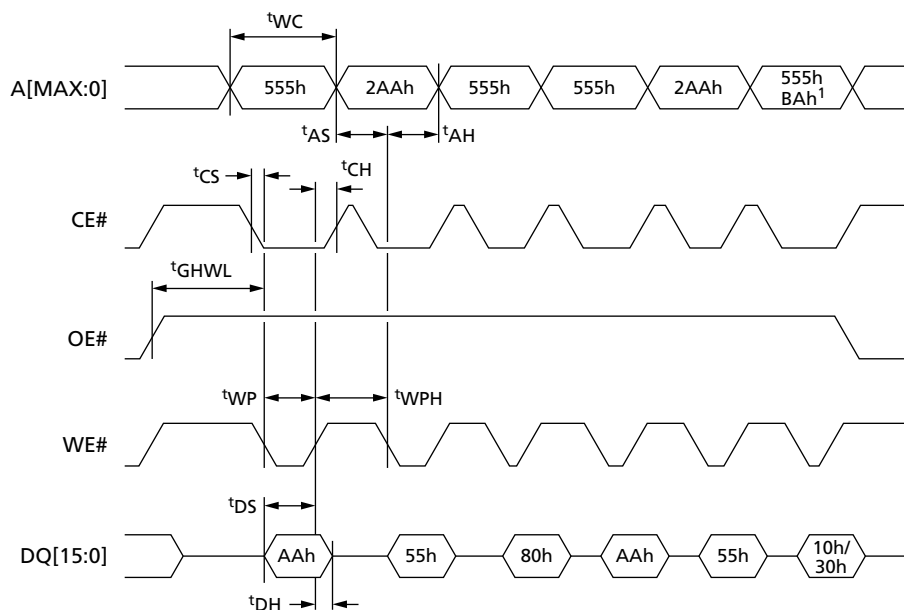
- Notes:
1. The user's write timing must comply with this specification. Any violation of this write timing specification may result in permanent damage to the NOR Flash device.
  2. Sampled only; not 100% tested.

**Figure 21: CE#-Controlled Program AC Timing**



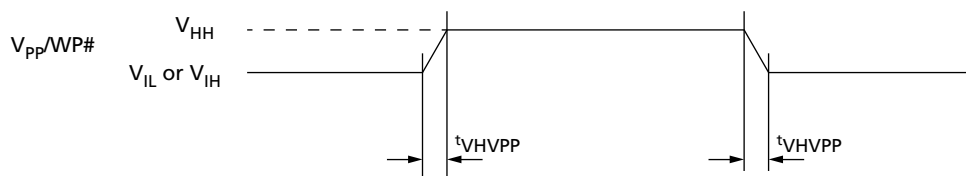
- Notes:
1. Only the third and fourth cycles of the PROGRAM command are represented. The PROGRAM command is followed by checking of the status register data polling bit.
  2. PA is the address of the memory location to be programmed. PD is the data to be programmed.
  3. DQ7 is the complement of the data bit being programmed to DQ7 (See Data Polling Bit [DQ7]).
  4. See the following tables for timing details: Read AC Characteristics, WE#-Controlled Write AC Characteristics, and CE#-Controlled Write AC Characteristics.
  5. For  $t_{WHWH1}$  timing details, see the Program/Erase Characteristics table.

**Figure 22: Chip/Block Erase AC Timing**



- Notes:
1. For a CHIP ERASE command, the address is 555h, and the data is 10h; for a BLOCK ERASE command, the address is BAd, and the data is 30h.
  2. BAd is the block address.
  3. See the following tables for timing details: Read AC Characteristics, WE#-Controlled Write AC Characteristics, and CE#-Controlled Write AC Characteristics.
  4. For tWHWH1 timing details, see the Program/Erase Characteristics table.

**Figure 23: Accelerated Program AC Timing**



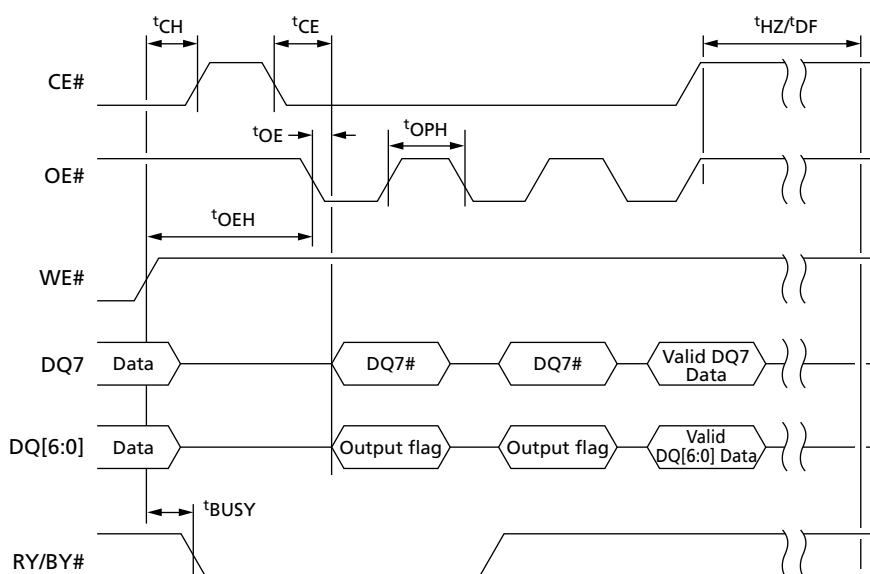
## Data Polling/Toggle AC Characteristics

**Table 35: Data Polling/Toggle AC Characteristics**

Note 1 applies to entire table

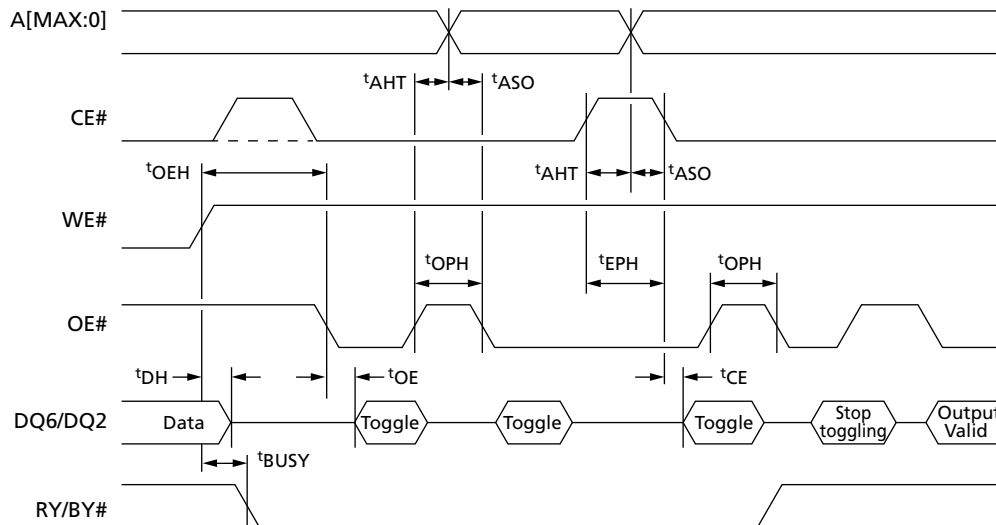
| Parameter                                     | Symbol    |                         | Min | Max | Unit |
|-----------------------------------------------|-----------|-------------------------|-----|-----|------|
|                                               | Legacy    | JEDEC                   |     |     |      |
| Address setup time to CE# or OE# LOW          | $t_{ASO}$ | $t_{AXGL}$              | 15  | –   | ns   |
| Address hold time from OE# or CE# HIGH        | $t_{AHT}$ | $t_{GHAX}$ , $t_{EHAX}$ | 0   | –   | ns   |
| CE# HIGH time                                 | $t_{EPH}$ | $t_{EHEL2}$             | 20  | –   | ns   |
| OE# HIGH time                                 | $t_{OPH}$ | $t_{GHGL2}$             | 20  | –   | ns   |
| WE# HIGH to OE# LOW (toggle and data polling) | $t_{OEH}$ | $t_{WHGL2}$             | 10  | –   | ns   |

Note: 1. Sampled only; not 100% tested.

**Figure 24: Data Polling AC Timing**


- Notes:
1. DQ7 returns a valid data bit when the PROGRAM or ERASE command has completed.
  2. See the following tables for timing details: Read AC Characteristics and Data Polling/Toggle AC Characteristics.

**Figure 25: Toggle/Alternative Toggle Bit Polling AC Timing**



- Notes:
1. DQ6 stops toggling when the PROGRAM or ERASE command has completed. DQ2 stops toggling when the CHIP ERASE or BLOCK ERASE command has completed.
  2. See the following tables for timing details: Read AC Characteristics and Data Polling/Toggle AC Characteristics.

## Program/Erase Characteristics

**Table 36: Program/Erase Characteristics**

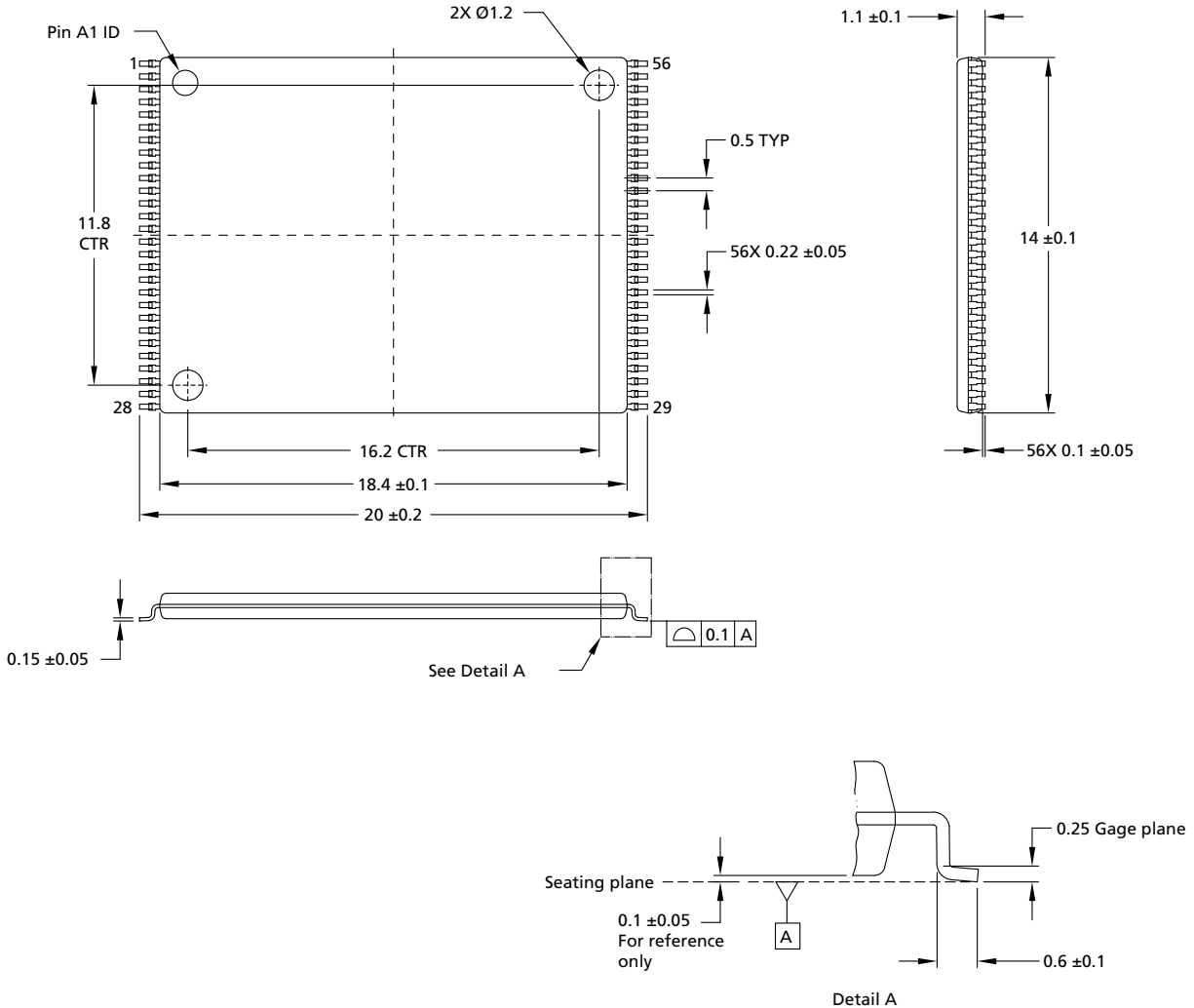
Notes 1 and 2 apply to entire table

| Parameter                                                        | Buffer Size | Byte | Word | Min     | Typ  | Max   | Unit   | Notes |
|------------------------------------------------------------------|-------------|------|------|---------|------|-------|--------|-------|
| <b>Erase</b>                                                     |             |      |      |         |      |       |        |       |
| Block erase (128KB)                                              | –           | –    | –    | –       | 200  | 1100  | ms     | –     |
| Chip erase                                                       | –           | –    | –    | –       | 208  | –     | s      | –     |
| Erase suspend latency time                                       | –           | –    | –    | –       | –    | 20    | μs     | –     |
| Erase or erase resume to suspend                                 | –           | –    | –    | –       | 100  | –     | μs     | 3, 4  |
| Accelerated chip erase                                           | –           | –    | –    | –       | 190  | –     | s      | –     |
| <b>Program</b>                                                   |             |      |      |         |      |       |        |       |
| Single-word program                                              | –           | –    | –    | –       | 25   | 200   | μs     | –     |
| <b>Buffer Program</b>                                            |             |      |      |         |      |       |        |       |
| Word write to buffer program ( <sup>t</sup> WHWH1)               | 32          | –    | 32   | –       | 92   | 460   | μs     | –     |
|                                                                  | 64          | –    | 64   | –       | 117  | 600   | μs     | –     |
|                                                                  | 128         | –    | 128  | –       | 171  | 900   | μs     | –     |
|                                                                  | 256         | –    | 256  | –       | 285  | 1500  | μs     | –     |
|                                                                  | 512         | –    | 512  | –       | 512  | 2000  | μs     | –     |
| Effective write to buffer program per word ( <sup>t</sup> WHWH1) | 32          | –    | 1    | –       | 2.88 | 14.38 | μs     | –     |
|                                                                  | 64          | –    | 1    | –       | 1.83 | 9.38  | μs     | –     |
|                                                                  | 128         | –    | 1    | –       | 1.34 | 7.03  | μs     | –     |
|                                                                  | 256         | –    | 1    | –       | 1.11 | 5.86  | μs     | –     |
|                                                                  | 512         | –    | 1    | –       | 1.0  | 3.90  | μs     | –     |
| Accelerated full buffer program time                             | –           | –    | –    | –       | 410  | –     | μs     | –     |
| Program suspend latency time                                     | –           | –    | –    | –       | –    | 15    | μs     | –     |
| <b>Nonvolatile protection</b>                                    |             |      |      |         |      |       |        |       |
| Set nonvolatile protection bit time                              | –           | –    | –    | –       | 25   | 320   | μs     | –     |
| Clear nonvolatile protection bit time                            | –           | –    | –    | –       | 80   | 1100  | ms     | –     |
| <b>Blank Check, CRC, and Program/Erase Endurance</b>             |             |      |      |         |      |       |        |       |
| Blank check: main block                                          | –           | –    | –    | –       | 3.2  | –     | ms     | –     |
| CRC check time: main block                                       | –           | –    | –    | –       | 5    | –     | ms     | –     |
| CRC check time: full chip (512Mb)                                | –           | –    | –    | –       | 5    | –     | s      | –     |
| PROGRAM/ERASE cycles (per block)                                 | –           | –    | –    | 100,000 | –    | –     | cycles | –     |

- Notes:
1. Typical values measured at room temperature and nominal voltages ( $V_{CC} = 3V$ ).
  2. Typical and maximum values are sampled, but not 100% tested.
  3. Erase to suspend is the time between an initial BLOCK ERASE or ERASE RESUME command and a subsequent ERASE SUSPEND command.
  4. This typical value allows an ERASE operation to progress to completion—it is important to note that the algorithm might never finish if the ERASE operation is *a*lways suspended less than this specification.

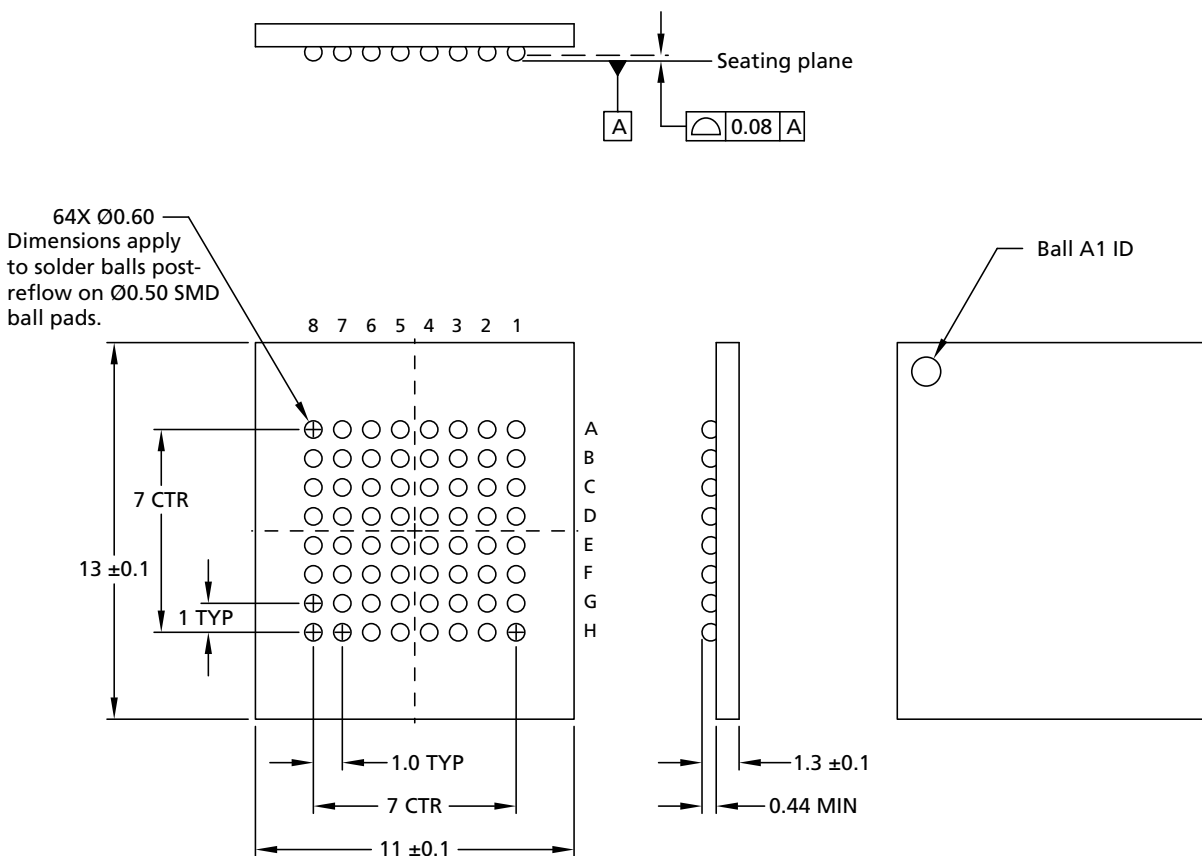
## Package Dimensions

**Figure 26: 56-Pin TSOP – 14mm x 20mm (Package Code: JS)**



- Notes:
1. All dimensions are in millimeters.
  2. Pin A1 ID diameter is 1mm.
  3. New package assembly site has effected an ASE process change (original ASE process is Amkor). The package shows two eject pins on the package mark: one in the corner by pin 56 and one in the corner by pin 28, each with diameter 2mm x 1.2mm.
  4. Package width and length include mold flash.

**Figure 27: 64-Ball LBGA – 11mm x 13mm (Package Code: PC)**



Note: 1. All dimensions are in millimeters.

## Revision History

### Rev. H – 05/18

- Added Important Notes and Warnings section for further clarification aligning to industry standards

### Rev. G – 11/16

- Updated 56-pin dimension drawing
- Added Note 4 to 56-pin dimension drawing

### Rev. F – 6/16

- Updated Table 21: CFI Query System Interface Information in Common Flash Interface

### Rev. E – 9/15

- Updated Table 31: Read AC Characteristics –  $t_{PAGE}$  in Read AC Characteristics

### Rev. D – 01/15

- Promoted the document from Preliminary to Production status

### Rev. C – 12/14

- Updated Figure 4: 64-Ball LBGA in Signal Assignments
- Updated Table 21: CFI Query System Interface Information in Common Flash Interface
- Updated Table 23: Primary Algorithm-Specific Extended Query Table in Common Flash Interface
- Updated Table 28: Input/Output Capacitance in Absolute Ratings and Operating Conditions
- Updated Table 29: DC Current Characteristics in DC Characteristics
- Updated Table 31: Read AC Characteristics –  $V_{CC} = V_{CCQ} = 2.7\text{--}3.6\text{V}$  in Read AC Characteristics
- Updated Table 32: Read AC Characteristics –  $V_{CCQ} = 1.65\text{V} - V_{CC}$  in Read AC Characteristics
- Updated Table 36: Program/Erase Characteristics in Program/Erase Characteristics

### Rev. B – 07/14

- Preliminary status

### Rev. A – 05/14

- Initial release



## 1Gb: x16, 3V, MT28FW, Automotive Parallel NOR Revision History

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This data sheet contains minimum and maximum limits specified over the power supply and temperature range set forth herein. Although considered final, these specifications are subject to change, as further product development and data characterization sometimes occur.

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